ANALOG DEVICES

Dual-Mode, Ka Band Upconverter with Integrated Fractional-N PLL and VCO

Data Sheet

ADMV4530

FEATURES

RF output frequency range: 27 GHz to 31 GHz Two upconversion modes Direct upconversion from differential baseband I/Q (I/Q mode) Single upper sideband upconversion (IF mode) 1 dB bandwidth: 500 MHz (I/Q mode) Input frequency range: 2 GHz to 3 GHz (IF mode) Matched, 50 Ω, single-ended RF output Matched, 50 Ω, single-ended IF input Programmable baseband I/Q common mode-voltage Sideband rejection and carrier feedthrough optimization Combined RF and IF gain dynamic range: 70 dB Programmable automatic IF gain control Programmable via 3-wire or 4-wire SPI 40-terminal, 6 mm × 6 mm, RoHS compliant LGA

APPLICATIONS

Satellite communication Point to point microwave communication

GENERAL DESCRIPTION

The ADMV4530 is a highly integrated upconverter with an in-phase/quadrature (I/Q) mixer that is ideally suited for next generation Ka band satellite communications.

An integrated low phase noise, fractional-N phase-locked loop (PLL) with a voltage controlled oscillator (VCO) and internal 2× multiplier generate the necessary on-chip local oscillator (LO) signal for the I/Q mixer, eliminating the need for external frequency synthesis. The VCO uses an internal autocalibration routine that allows the PLL to select the necessary settings and locks in approximately 100 µs.

The single-ended reference input to the PLL operates up to 500 MHz and features internal reference dividers and a multiplier for added flexibility. Additionally, the phase frequency detector (PFD) comparison frequency can be up to 250 MHz for integer mode and 160 MHz for fraction-N mode.

The upconverter consists of an I/Q mixer that can operate in either I/Q mode with 500 MHz of bandwidth or in IF mode up to 3 GHz of bandwidth, which allows various radio architectures and backward compatibility with legacy systems.

Immediately following the I/Q mixer are stages of gain and variable attenuation. The configuration can achieve a minimum 1 dB compression point (P1dB) compression point of 19 dBm, eliminating the need for external stages of gain.

A programmable 4-wire serial port interface (SPI) allows adjustment of the quadrature phase for optimum sideband suppression. In addition, the SPI allows nulling of LO feedthrough in IF mode. In I/Q mode, the LO feedthrough can be nulled by applying external dc offset to the differential baseband I/Q inputs.

An IF automatic gain control (AGC) adjusts the IF variable gain amplifier (VGA) to compensate for input power variations. During normal operation, this AGC feature can be enabled or disabled via the SPI. When disabled during normal operation, the AGC feature only works on a test tone during power-down mode to track temperature variations.

The ADMV4530 upconverter comes in a RoHs compliant, 6 mm × 6 mm, 40-terminal land grid array (LGA) package. The ADMV4530 operates over the -40° C to $+85^{\circ}$ C case temperature range.

Rev. B

Document Feedback

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REVISION HISTORY

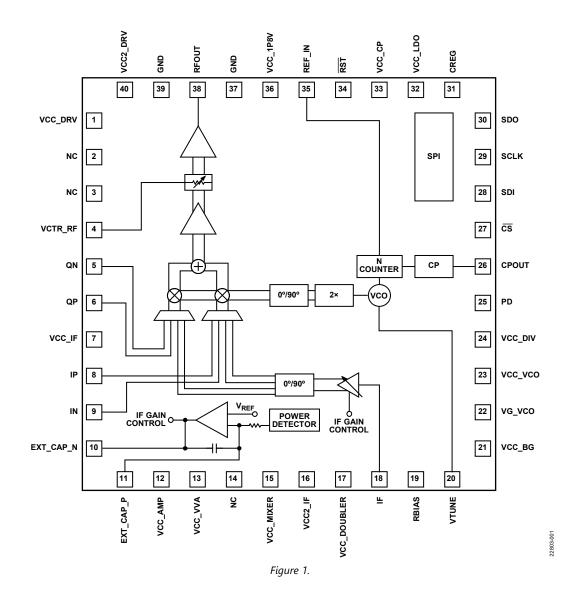
| 6/2022—Rev. A to Rev. B |
|--|
| Changes throughout, particularly prescaler |
| recommendation1-63 |

3/2020—Rev. 0 to Rev. A Change to Data Sheet Title1

3/2020—Revision 0: Initial Version

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FUNCTIONAL BLOCK DIAGRAM



SPECIFICATIONS

 $VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, and T_A = 25°C, unless otherwise noted.$

| Table 1. | | | | | | | |
|--|------|------|-----|--------|--|--|--|
| Parameter | Min | Тур | Max | Unit | Test Conditions/Comments | | |
| LO FREQUENCY RANGE | 25.6 | | 30 | GHz | | | |
| VCO | | | | | | | |
| Frequency Range | 12.8 | | 15 | GHz | | | |
| Voltage Range (V _{TUNE}) | 0.5 | | 2.8 | V | | | |
| Tuning Sensitivity (K _{VCO}) | | 165 | | MHz/V | At VCO frequency | | |
| Open-Loop Phase Noise | | | | | | | |
| 1 kHz Offset | | -49 | | dBc/Hz | | | |
| 10 kHz Offset | | -76 | | dBc/Hz | | | |
| 100 kHz Offset | | -102 | | dBc/Hz | | | |
| 1 MHz Offset | | -125 | | dBc/Hz | | | |
| 10 MHz Offset | | -145 | | dBc/Hz | | | |
| 40 MHz Offset | | -150 | | dBc/Hz | | | |
| PLL | | | | | | | |
| Reference Input | | | | | | | |
| Voltage | 0 | | 1.8 | V р-р | | | |
| Capacitance | | 7 | | рF | | | |
| Reference Frequency | | 200 | | MHz | | | |
| PFD Frequency | | | | | | | |
| Integer Mode | | 250 | | MHz | | | |
| Fractional-N Mode | | 160 | | MHz | | | |
| PFD In Band Phase Noise | | -147 | | dBc/Hz | PFD frequency (f_{PFD}) = 200 MHz | | |
| Lock Detect | | | | | | | |
| Locked | | | 3.3 | V | | | |
| Unlocked | 0.1 | 0.3 | 0.5 | V | | | |
| Reset Timing | 4 | | | µsec | Time requirement for all registers to reset. | | |

I/Q MODE

I/Q frequency = 25 MHz, I/Q input power = -10 dBm, RF frequency = 29 GHz, 1 MHz tone spacing, upper sideband, R_WORD = 2, CP_CURRENT = 4.20 mA, REF_IN power = 8 dBm, REF_IN frequency = 200 MHz, loop filter bandwidth = 540 kHz, VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, T_A = 25°C, common-mode voltage (V_{CM}) = 0.5 V, VCTR_RF = 1.8 V, and board losses de-embedded to the device, unless otherwise noted.

| Table 2. | | | | | |
|--|-----|------|-----|--------|---|
| Parameter | Min | Тур | Мах | Unit | Test Conditions/Comments |
| OUTPUT FREQUENCY RANGE | 27 | | 31 | GHz | |
| OUTPUT RETURN LOSS | | -4 | | dB | |
| RF GAIN | 17 | 21 | | dB | |
| Flatness | | ±1 | | dB | |
| Dynamic Range | | 30 | | dB | |
| VCTR_RF Control | | | | | |
| Range | 0 | | 1.8 | V | |
| Slope | | 32 | | dB/V | VCTR_RF = 0.6 V to 1.5 V |
| 1 dB COMPRESSION POINT (P1dB) | 17 | 19 | | dBm | Maximum gain |
| OUTPUT THIRD-ORDER DISTORTION (IP3) | | 29 | | dBm | Maximum gain, –10 dBm per tone, 1 MHz tone spacing |
| NOISE DENSITY | | -139 | | dBm/Hz | Maximum gain |
| OUTPUT SPURIOUS | | | | | Spurs at maximum gain |
| Reference Spurs | | -65 | | dBm | |
| VCO Feedthrough | | -75 | | dBm | |
| 1 dB BANDWIDTH | | 500 | | MHz | Per differential I and Q inputs |
| I/Q COMMON-MODE VOLTAGE (V _{CM}) | 0 | 0.5 | 2.5 | V | |
| DIFFERENTIAL INPUT IMPEDANCE | | 100 | | Ω | |
| SIDEBAND REJECTION | | -27 | | dBc | Uncalibrated |
| LO TO RF LEAKAGE | | | | | |
| Minimum Gain | | -41 | | dBm | Uncalibrated |
| Maximum Gain | | -15 | | dBm | Uncalibrated |
| | | -45 | | dBm | Calibrated |
| SUPPLY VOLTAGE | | | | | |
| | 3.8 | 4.0 | 4.2 | V | VCC_DRV, VCC_AMP, and VCC2_DRV pins |
| | 3.2 | 3.3 | 3.4 | V | VCC_IF, VCC2_IF, VCC_VVA, VCC_MIXER, VCC_DOUBLER, VCC_BG, VCC_VCO, VCC_DIV, VCC_LDO, and VCC_CP |
| | | | | | pins |
| | 1.7 | 1.8 | 1.9 | v | VCC_1P8V |
| SUPPLY CURRENT | | | | | |
| | | 200 | | mA | VCC_DRV, VCC_AMP, and VCC2_DRV pins |
| | | 320 | | mA | VCC_IF, VCC2_IF, VCC_VVA, VCC_MIXER, VCC_DOUBLER, |
| | | | | | VCC_BG, VCC_VCO, VCC_DIV, VCC_LDO, and VCC_CP |
| | | | | | pins |
| | | 2 | | mA | VCC_1P8V |

IF MODE

IF frequency = 2.7 GHz, IF power = -41 dBm, RF frequency = 29 GHz, 1 MHz tone spacing, upper sideband, R_WORD = 4, CP_CURRENT = 2.10 mA, REF_IN power = 8 dBm, REF_IN frequency = 200 MHz, loop filter bandwidth = 100 kHz, VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, T_A = 25°C, VCTR_RF = 1.8 V, VCTR_IF = 0 V, and board losses de-embedded to the device, unless otherwise noted. Note that VCTR_IF is the voltage applied to the EXT_CAP_x pins.

Table 3.

| Parameter | Mi n | Тур | Мах | Unit | Test Conditions/Comments |
|------------------------|---------|------|-----|--------|--|
| OUTPUT FREQUENCY RANGE | 28 | | 30 | GHz | |
| OUTPUT RETURN LOSS | | -4 | | dB | |
| GAIN | | 50 | | dB | VCTR_IF = 0 V |
| Flatness | | 0.25 | | dB | Within a bandwidth of 50 MHz |
| Dynamic Range | | 70 | | dB | VCTR_RF and VCTR_IF combined dynamic range |
| VCTR_RF Control | | | | | |
| Range | 0 | | 1.8 | v | |
| Slope | | 32 | | dB/V | VCTR RF = 0.6 V to 1.5 V |
| VCTR_IF Control | | | | | |
| AGC Set Voltage | 0 | | 2.5 | V | Accessed via SPI map |
| Range | 0 | | 3.3 | V | When bypassing AGC |
| Slope | | -32 | | dB/V | VCTR_IF = 0.9 V to 2.2 V for both AGC or external |
| | | | | | control voltage |
| P1dB | 17 | 19 | | dBm | Maximum gain |
| OUTPUT IP3 | | 29 | | dBm | Maximum gain, –41 dBm per tone, 1 MHz tone spacing |
| NOISE DENSITY | | -13 | | dBm/Hz | Maximum gain |
| | | 9 | | | |
| OUTPUT SPURIOUS | | | | | Spurs at maximum gain |
| Reference Spurs | | -65 | | dBm | |
| VCO Feedthrough | | -75 | | dBm | |
| LO TO RF LEAKAGE | | -10 | | dBm | Uncalibrated |
| | | -35 | | dBm | Calibrated |
| SIDEBAND REJECTION | -2 4 | -35 | | dBc | Uncalibrated |
| INPUT RANGE | | | | | |
| Frequency | 2 | 2.5 | 3 | GHz | |
| Power | | | 0 | dBm | |
| INPUT RETURN LOSS | | 12 | | dB | |
| SUPPLY VOLTAGE | | | | | |
| | 3.8 | 4.0 | 4.2 | V | VCC_DRV, VCC_AMP, and VCC2_DRV pins |
| | 3.2 | 3.3 | 3.4 | V | VCC_IF, VCC2_IF, VCC_VVA, VCC_MIXER, VCC_DOUBLER, |
| | | | | | VCC_BG, VCC_VCO, VCC_DIV, VCC_LDO, and VCC_CP pins |
| | 1.7 | 1.8 | 1.9 | V | VCC_1P8V |
| SUPPLY CURRENT | | | | | |
| | | 190 | | mA | VCC_DRV, VCC_AMP, and VCC2_DRV pins |
| | | 470 | | mA | VCC_IF, VCC2_IF, VCC_VVA, VCC_MIXER, VCC_DOUBLER, VCC_BG, VCC_VCO, VCC_DIV, VCC_LDO, and VCC_CP pins |
| | | 2 | | mA | VCC_1P8V |

ABSOLUTE MAXIMUM RATINGS

Table 4.

| Parameter | Rating |
|----------------------------------|-----------------------|
| VCC_DRV, VCC_AMP, and VCC2_DRV | 5 V |
| VCC_IF, VCC2_IF, VCC_VVA, | 4.3 V |
| VCC_MIXER, VCC_DOUBLER, | |
| VCC_BG | |
| VCC_VCO, VCC_DIV, VCC_LDO, | 3.6 V |
| VCC_CP | |
| VCC_1P8V | 2.3 V |
| REF_IN to GND | -0.3 V to +2.1 V |
| Input Power | |
| IF | 10 dBm |
| I/Q | 5 dBm |
| Temperature | |
| Junction | 125°C |
| Lifetime at Maximum Junction | 10 ⁶ hours |
| (T _J) | |
| Operating Range | -40°C to +85°C |
| Storage Range | -55°C to +150°C |
| Lead Range (Soldering 60 sec) | 260°C |
| Moisture Sensitivity Level (MSL) | MSL3 |
| Rating | |
| Electrostatic Discharge (ESD) | |
| Sensitivity | |
| Human Body Model (HBM) | 1000 V |
| Field Induced Charged Device | 1000 V |
| Model (FICDM) | |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL INFORMATION

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

 θ_{JA} is the natural convection junction to ambient thermal resistance measured in a one cubic foot sealed enclosure. θ_{JC} is the junction to case thermal resistance.

Only use θ_{JA} and θ_{JC} to compare the thermal performance of different packages when all test conditions listed are similar to JEDEC specifications. Otherwise, use Ψ_{JT} and Ψ_{JB} to calculate the device junction temperature using the following equations:

$$T_J = (P \times \Psi_{JT}) + T_{TOP} \tag{1}$$

where:

P is the total power dissipation in the chip (W). Ψ_{JT} is the junction to top thermal characterization number.

 T_{TOP} is package top temperature (°C). T_{TOP} is measured at the top center of the package.

$$T_J = (P \times \Psi_{JB}) + T_{BOARD} \tag{2}$$

where:

P is the total power dissipation in the chip (W). Ψ_{JB} is the junction to board thermal characterization number.

 T_{BOARD} is the board temperature measured on the midpoint of the longest side of the package, no more than 1 mm from the edge of the package body (°C).

As stated in JEDEC51-12, only use Equation 1 and Equation 2 when no heat sink or heat spreader is present. When a heat sink or heat spreader is added, use θ_{JC_TOP} or θ_{JC_BOT} (Table 6) to estimate or calculate the junction temperature. The preferred heat sink or heat spreader placement for this device is to contact the bottom of the board that has enough number of thru vias thermally connecting the bottom paddle of the device to the heatsink along with an appropriate thermal insulating material (TIM) to efficiently reduce the junction temperature of the device.

Table 5 shows the temperature rise from case to junction (ΔT_{JC}) based on a detailed power map on a JEDEC (JESD51-2) board as opposed to a JEDEC thermal characterization number used to get the average temperature due to uniform power dissipation across the ADMV4530 die. This would result in a higher calculated junction temperature but sets the correct limit to the maximum case temperature with the ADMV4530 mounted on a JEDEC board. There is one ΔT_{JC} value that applies for both modes of operation.

To calculate $T_{BOARD,max}$ (Maximum case temperature referred to the bottom of the package/ nearest point on the board to the package) use Equation 3 and Equation 4 and refer to Figure 2:

 $T_{BOARD, MAX} = T_{J, MAX} - \Delta T_{JC} - P \times \theta_{JC_BOT}$ (3)

if bottom side is applied to the PCB bottom surface then:

 $T_{BOARD} = T_{BASE_PLATE} + P \times \theta_{BOARD} + P \times \theta_{TIM}$ (4) where:

P is the total power dissipation in the chip (W). $T_{J,MAX}$ is the maximum junction temperature (°C) in Table 4.

 $T_{BOARD, MAX}$ is the maximum board temperature measured on the midpoint of the longest side of the package no more than 1 mm from the edge of the package body (°C) ΔT_{JC} is the highest temperature rise (°C) from case to junction in Table 5.

 T_{BOARD} is the board temperature measured on the midpoint of the longest side of the package no more than 1 mm from the edge of the package body (°C)

 T_{BASE_PLATE} is the temperature of the base plate of the heats ink

 θ_{TIM} is the thermal resistance (°C/W) of the TIM θ_{BOARD} is the thermal resistance (°C/W) of the board θ_{JC_BOT} is the junction to top case thermal resistance (°C/W) in Table 6.

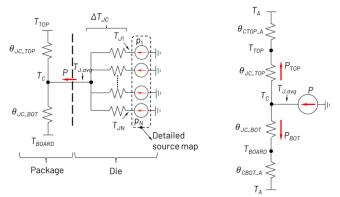


Figure 2. Circuit Level Description of Power Map (left) and Uniform Power Dissipation Methods (right)

Table 5. Thermal Rise from Case to Junction

| Operational Mode | ΔT_{JC} | Unit |
|------------------|-----------------|------|
| IF and I/Q mode | 32 | °C |

The thermal resistance of the ADMV4530 assuming the JEDEC standard of uniform power dissipation based on a JEDEC (JESD51-2) board is shown in Table 6. Thermal resistance based on a uniform power dissipation is useful to compare the performance of the ADMV4530 to other similar ICs.

Table 6. Thermal Resistance

| Package Type | θ _{JC_BOT} 1 | θ _{JC_TOP} 1 | Ψ,τ | ΨյΒ | Αιθ | Unit |
|-----------------|-----------------------|-----------------------|-----|-----|------|------|
| CC-40-8 | 3.9 | 11.7 | 3.0 | 8.5 | 28.2 | °C/W |

¹ See JEDEC Standard JESD51-2 for additional information on optimizing the thermal impedance.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

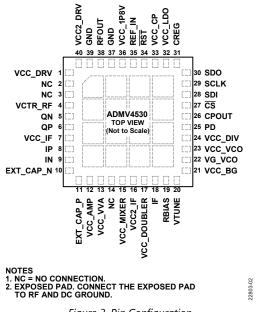


Figure 3. Pin Configuration

| Pin | Mnemonic | Description |
|---------------|---------------------|---|
| No. | | |
| 1, 12, | VCC_DRV, VCC_AMP, | Supply Voltages for the RF Output Driver, 4.0 V. Place a 1 μ F decoupling capacitor close |
| 40 | VCC2_DRV | to each pin. |
| 2, 3, 14 | NC | No Connection. |
| 4 | VCTR_RF | RF Gain Control, 0 V to 1.8 V. Apply voltage to VCTR_RF after all other supply pins have been powered. If that is not possible, then be sure to install approximately 1 k Ω in series with VCTR_RF. |
| 5, 6, 8, 9 | QN, QP, IP, IN | Differential Quadrature Baseband Inputs. These 100 Ω differential impedance inputs can be common-mode dc biased from 0 V to 2.5 V. |
| 7, 16 | VCC_IF, VCC2_IF | Supply Voltages for the IF and Baseband Inputs, 3.3 V. Place a 1 μF decoupling capacitor close to each pin. |
| 10 | EXT_CAP_N (VCTR_IF) | IF Gain Control Capacitor Negative Terminal. To adjust the IF gain manually, this pin must be driven externally when the AGC functionality is disabled, 0 V to 3.3 V. Note that VCTR_IF is the voltage applied to the EXT_CAP_x pins. Apply voltage to EXT_CAP_N after all other supply pins have been powered. If that is not possible, then be sure to install approximately 1 k Ω in series with EXT_CAP_N. |
| 11 | EXT_CAP_P | IF Gain Control Capacitor Positive Terminal. Note that VCTR_IF is the voltage applied to the EXT_CAP_x pins. |
| 13 | VCC_VVA | Supply Voltage for the Variable Gain Amplifier, 1.8 V. Place a 1 μF decoupling capacitor close to this pin. |
| 15 | VCC_MIXER | Supply Voltage for the Mixer, 3.3 V. Place a 1 μ F decoupling capacitor close to this pin. |
| 17 | VCC_DOUBLER | Supply Voltage for the Internal 2× Multiplier, 3.3 V. Place a 1 μF decoupling capacitor close to this pin. |
| 18 | IF | IF Input. This pin has a 50 Ω input impedance. |
| 19 | RBIAS | Resistor Band Gap Reference Bias. Place a precision 680 Ω resistor to ground at this pin. |

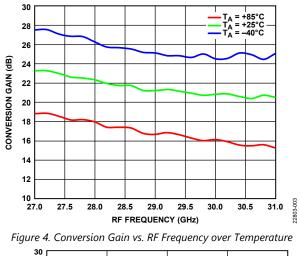
Table 7. Pin Function Descriptions

| Pin No. | Mnemonic | Description | | | | |
|------------|----------|---|--|--|--|--|
| 20 | VTUNE | VCO Tune Port, 0.5 V to 2.8 V. This pin is driven by the output of the loop filter. | | | | |
| 21 | VCC_BG | Supply Voltage for the Internal Band Gap, 3.3 V. Place a 1 μF decoupling capacitor close to this pin. | | | | |
| 22 | VG_VCO | VCO Gate Decoupling. Place a 10 μ F decoupling capacitor at this pin. | | | | |
| 23 | VCC_VCO | Supply Voltage for the VCO, 3.3 V. Place a 1 μ F decoupling capacitor close to this pin. | | | | |
| 24 | VCC_DIV | Supply Voltage for Fractional-N PLL, 3.3 V. Place a 1 μ F decoupling capacitor close to this pin. | | | | |
| 25 | PD | Power-Down, 3.3 V Logic. Active high. | | | | |
| 26 | CPOUT | Charge Pump Output. Connect this pin to VTUNE (Pin 20) through the loop filter. | | | | |
| 27 | CS | SPI Chip Select. 3.3 V logic. Active low. | | | | |
| 28 | SDI | SPI Data Input. 3.3 V logic. | | | | |
| 29 | SCLK | SPI Clock. 3.3 V logic. | | | | |
| 30 | SDO | SPI Data Output. 3.3 V logic. | | | | |
| 31 | CREG | External Capacitor for the Low Dropout (LDO) Regulator Output. Place a 0.1 μ F decoupling capacitor close to this pin. | | | | |
| 32 | VCC_LDO | Supply Voltage for the Internal LDO Regulator, 3.3 V. Place a 1 μ F decoupling capacitor close to this pin. | | | | |
| 33 | VCC_CP | Supply Voltage for the Charge Pump, 3.3 V. Place a 1 μ F decoupling capacitor close to this pin. | | | | |
| 34 | RST | Reset. 3.3 V logic. Active low. | | | | |
| 35 | REF_IN | PLL Reference Input. Apply an external reference signal to this pin with a 0.01 μ F, dc blocking capacitor. Refer to Figure 91 for the external reference input configuration. | | | | |
| 36 | VCC_1P8V | Supply Voltage for the SPI Block, 1.8 V. Place a 1 μ F decoupling capacitor close to this pin. The voltage on VCC_1P8V should be applied at the same time or after all other supply pin voltages have been applied. | | | | |
| 37, 39 | GND | Ground. Connect these pins to RF and dc ground. | | | | |
| 38 | RFOUT | RF Output. This pin has a 50 Ω output impedance. | | | | |
| | EPAD | Exposed Pad. Connect the exposed pad to RF and dc ground. | | | | |

TYPICAL PERFORMANCE CHARACTERISTICS

I/Q MODE

I/Q frequency = 25 MHz, I/Q input power = -10 dBm, RF frequency = 29 GHz, 1 MHz tone spacing, upper sideband, R_WORD = 2, CP_CURRENT = 4.20 mA, REF_IN power = 8 dBm, REF_IN frequency = 200 MHz, loop filter bandwidth = 540 kHz, VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, T_A = +25°C, -40°C, and +85°C, V_{CM} = 0.5 V, VCTR_RF = 1.8 V, and board losses de-embedded to the device, unless otherwise noted.



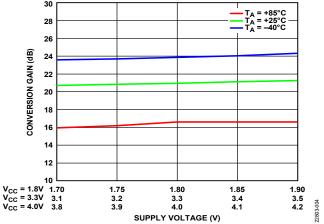


Figure 5. Conversion Gain vs. Supply Voltage over Temperature

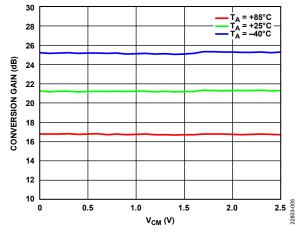


Figure 6. Conversion Gain vs. V_{CM} over Temperature

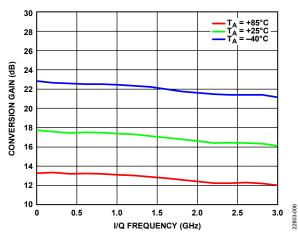


Figure 7. Conversion Gain vs. I/Q Frequency, Single Side Input over Temperature

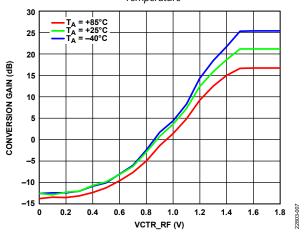


Figure 8. Conversion Gain vs. VCTR_RF over Temperature

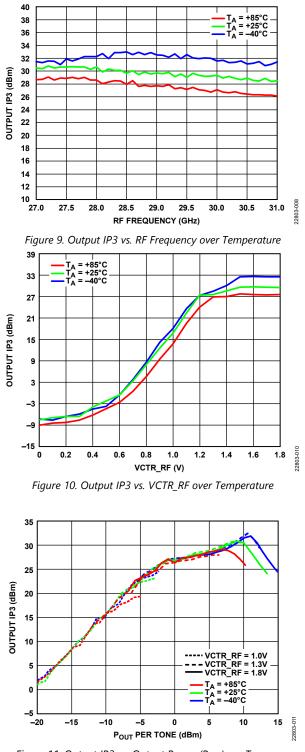


Figure 11. Output IP3 vs. Output Power (Pout) per Tone over Temperature

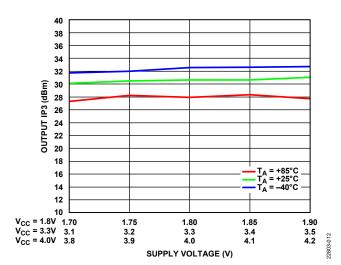
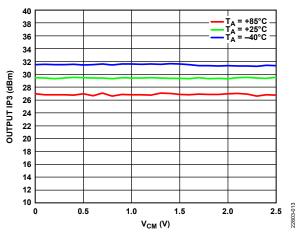
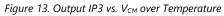


Figure 12. Output IP3 vs. Supply Voltage over Temperature





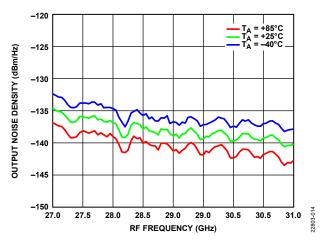


Figure 14. Output Noise Density vs. RF Frequency over Temperature

Data Sheet

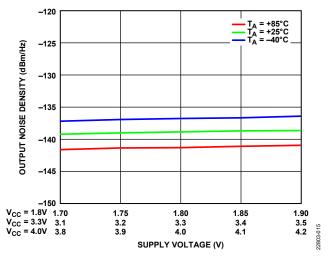


Figure 15. Output Noise Density vs. Supply Voltage over Temperature

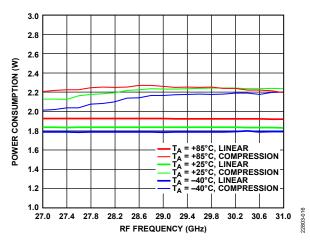


Figure 16. Power Consumption vs. RF Frequency over Temperature at Linear and Compression P_{OUT}

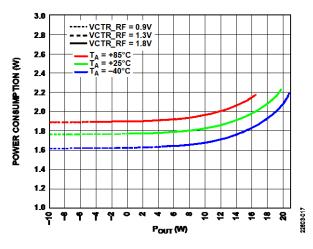


Figure 17. Power Consumption vs. POUT over Temperature

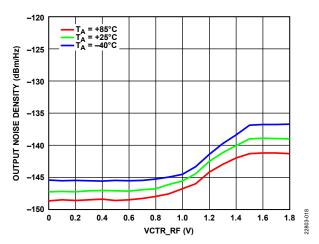


Figure 18. Output Noise Density vs. VCTR_RF over Temperature

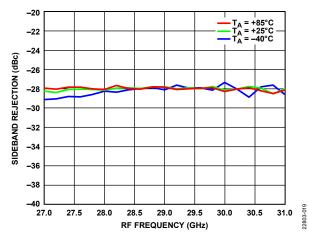


Figure 19. Sideband Rejection vs. RF Frequency over Temperature, Uncalibrated

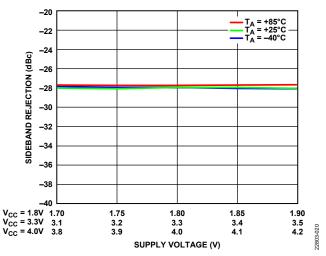


Figure 20. Sideband Rejection vs. Supply Voltage over Temperature, Uncalibrated

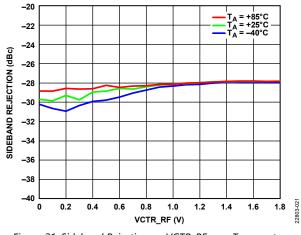


Figure 21. Sideband Rejection vs. VCTR_RF over Temperature, Uncalibrated

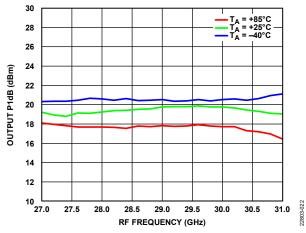


Figure 22. Output P1dB vs. RF Frequency over Temperature

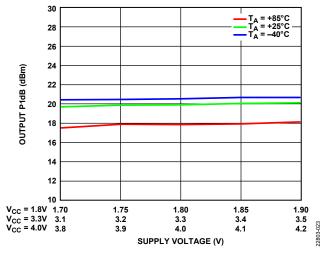


Figure 23. Output P1dB vs. Supply Voltage over Temperature

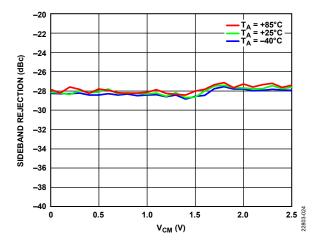


Figure 24. Sideband Rejection vs. VCM over Temperature, Uncalibrated

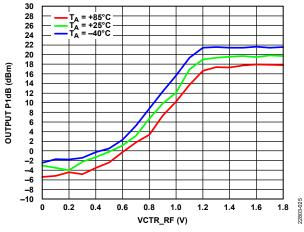


Figure 25. Output P1dB vs. VCTR_RF over Temperature

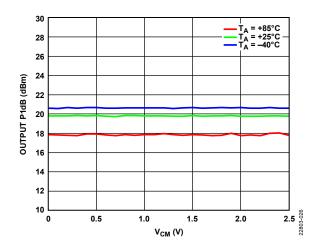


Figure 26. Output P1dB vs. V_{CM} over Temperature

Data Sheet

29GHz = +85°C = +25°C = -40°C -5 UNCALIBRATED -10 NDEBAND REJECTION (dBc) -15 --20 --25 = = -30 -35 -40 -45 -50 22803-058 27.4 27.8 28.2 29.8 30_2 31.0 27.0 28.6 29.0 29.4 30.6 **RF FREQUENCY (GHz)**

Figure 27. Sideband Rejection vs. RF Frequency over Temperature, Uncalibrated and Calibrated with RF Frequency = 29 GHz, VCTR_RF = 1.8 V at $T_A = 25^{\circ}$ C, I/Q Mode

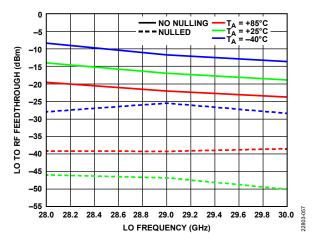


Figure 28. LO to RF Feedthrogh vs. LO Frequency over Temperature, Uncalibrated and Calibrated with LO Frequency = 28 GHz, 29 GHz, and 30 GHz, VCTR_RF = 1.8 V at T_A = 25°C, I/Q Mode

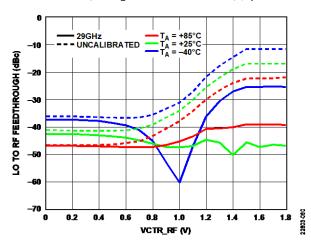


Figure 29. LO to RF Feedthrogh vs. VCTR_RF over Temperature, Uncalibrated and Calibrated with LO Frequency = 29 GHz at T_A = 25°C, I/Q Mode

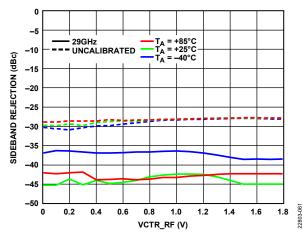


Figure 30. Sideband Rejection vs. VCTR_RF over Temperature, Uncalibrated and Calibrated with RF Frequency = 29 GHz at $T_A = 25$ °C, I/Q Mode

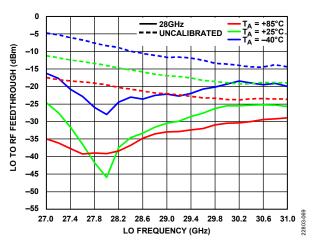


Figure 31. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 28 GHz at T_A = 25°C, I/Q Mode

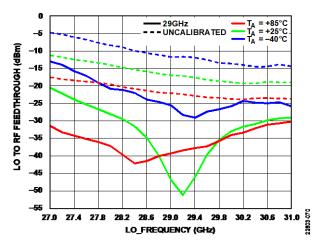


Figure 32. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 29 GHz at T_A = 25° C, I/Q Mode

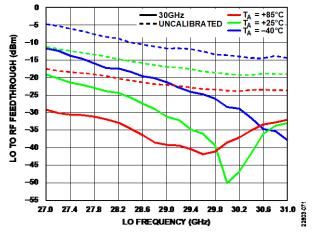


Figure 33. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 30 GHz at $T_A = 25^{\circ}$ C, I/Q Mode

IF MODE

IF frequency = 2.7 GHz, IF power = -41 dBm, RF frequency = 29 GHz, 1 MHz tone spacing, upper sideband, R_WORD = 4, CP_CURRENT = 2.10 mA, REF_IN power = 8 dBm, REF_IN frequency = 200 MHz, loop filter bandwidth = 100 kHz, VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, T_A = +25°C, -40°C, and +85°C, VCTR_RF = 1.8 V, VCTR_IF = 0 V, and board losses de-embedded to the device, unless otherwise noted. Note that VCTR_IF is the voltage applied to the EXT_CAP_x pins.

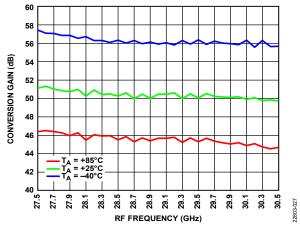


Figure 34. Conversion Gain vs. RF Frequency over Temperature

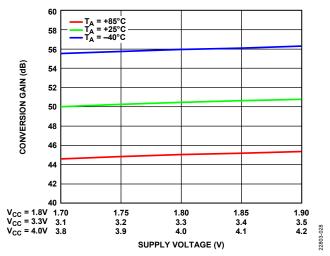


Figure 35. Conversion Gain vs. Supply Voltage over Temperature

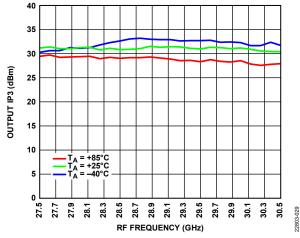


Figure 36. Output IP3 vs. RF Frequency over Temperature

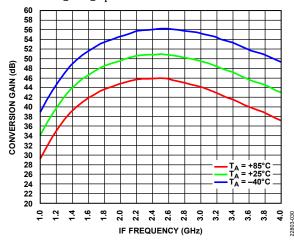


Figure 37. Conversion Gain vs. IF Frequency over Temperature

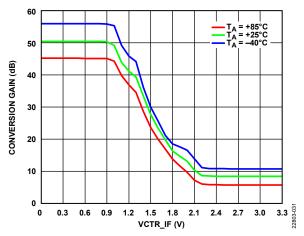


Figure 38. Conversion Gain vs. VCTR_IF over Temperature

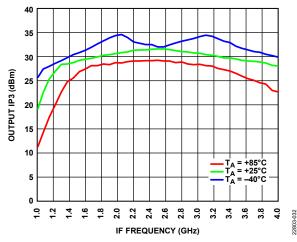


Figure 39. Output IP3 vs. IF Frequency over Temperature

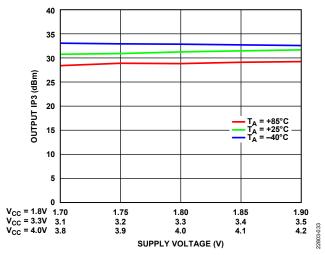


Figure 40. Output IP3 vs. Supply Voltage over Temperature

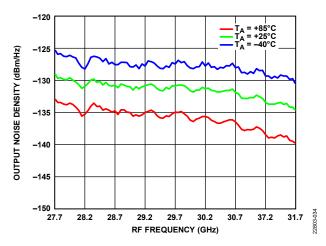


Figure 41. Output Noise Density vs. RF Frequency over Temperature

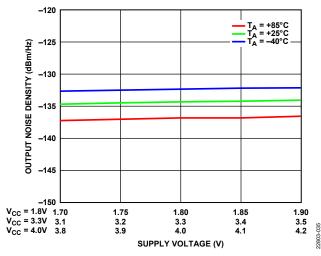


Figure 42. Output Noise Density vs. Supply Voltage over Temperature

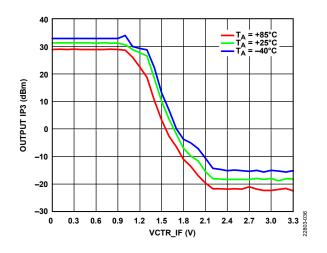


Figure 43. Output IP3 vs. VCTR_IF over Temperature

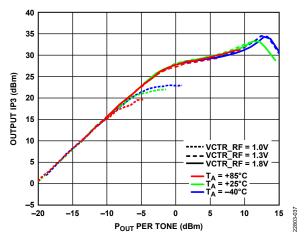


Figure 44. Output IP3 vs. P_{OUT} per Tone over Temperature and $V\text{CTR}_\text{RF}$

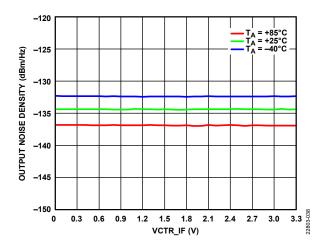


Figure 45. Output Noise Density vs. VCTR_IF over Temperature

Data Sheet

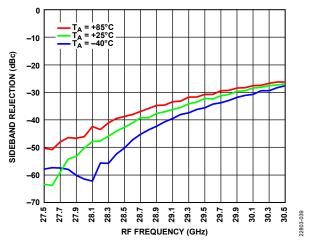


Figure 46. Sideband Rejection vs. RF Frequency over Temperature, Uncalibrated

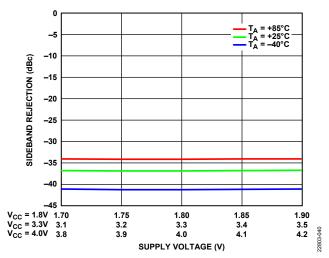


Figure 47. Sideband Rejection vs. Supply Voltage over Temperature, Uncalibrated

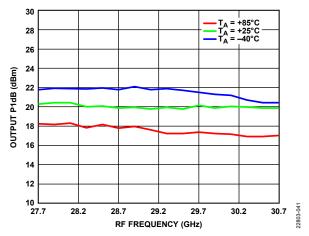


Figure 48. Output P1dB vs. RF Frequency over Temperature

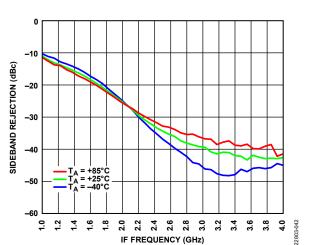


Figure 49. Sideband Rejection vs. IF Frequency over Temperature, Uncalibrated

IF FREQUENCY (GHz)

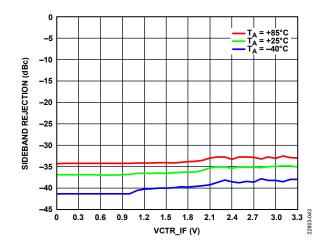


Figure 50. Sideband Rejection vs. VCTR_IF over Temperature, Uncalibrated

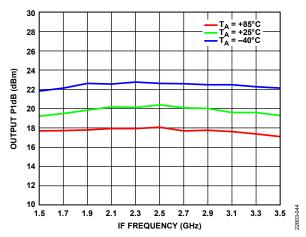


Figure 51. Output P1dB vs. IF Frequency over Temperature

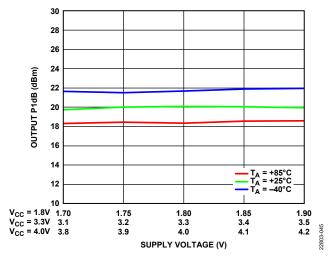


Figure 52. Output P1dB vs. Supply Voltage over Temperature

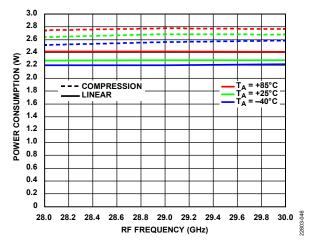


Figure 53. Power Consumption vs. RF Frequency over Temperature at Linear and Compression P_{OUT}

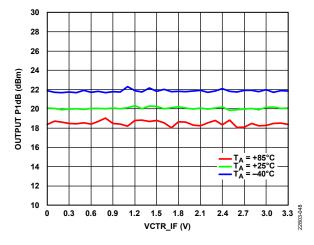


Figure 54. Output P1dB vs. VCTR_IF over Temperature

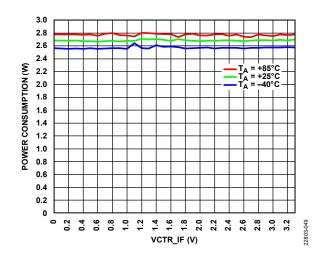


Figure 55. Power Consumption vs. VCTR_IF over Temperature at Compression P_{OUT}

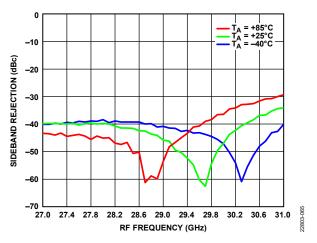


Figure 56. Sideband Rejection vs. RF Frequency over Temperature, Calibrated with RF Frequency = 30 GHz, IF Mode, VCTR_RF = 1.8 V, T_A = 25°C

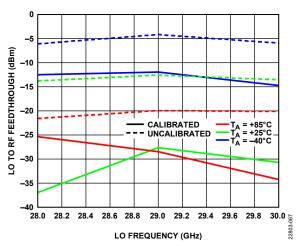


Figure 57. LO to RF Feethrough vs. LO Frequency, Calibrated at $T_A = 25$ °C and Not Calibrated, over Temperature

Data Sheet

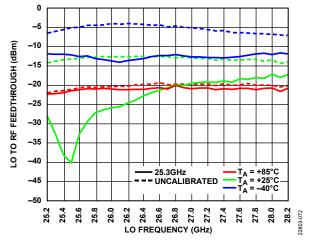


Figure 58. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 25.3 GHz at T_A = 25°C, IF Mode

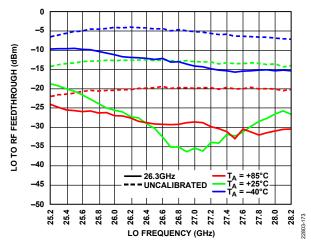


Figure 59. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 26.3 GHz at $T_A = 25$ °C, IF Mode

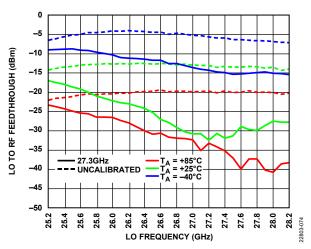


Figure 60. LO to RF Feethrough vs. LO Frequency, over Temperature, Not Calibrated and Calibrated with LO Frequency = 27.3 GHz at T_A = 25° C, IF Mode

RETURN LOSS AND LEAKAGES

 $VCC_DRV = VCC_AMP = VCC2_DRV = 4 V$, $VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V$, $VCC_1P8V = 1.8 V$, $T_A = +25^{\circ}C$, $-40^{\circ}C$, and $+85^{\circ}C$, $VCTR_RF = 1.8 V$, and $VCTR_IF = 0 V$, unless otherwise noted.

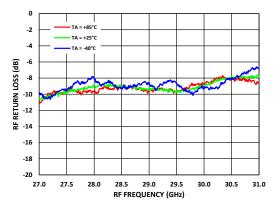


Figure 61. Output Return Loss vs. RF Frequency over Temperature

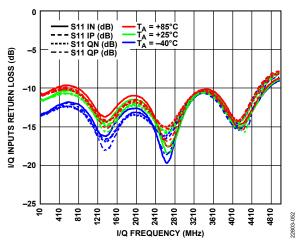


Figure 62. I/Q Inputs Return Loss vs. I/Q Frequency, Single-Ended over Temperature (S11 Is Return Loss)

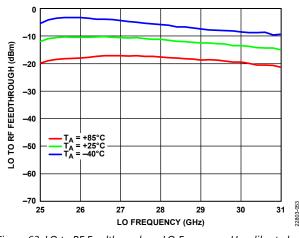


Figure 63. LO to RF Feedthrough vs. LO Frequency, Uncalibrated over Temperature

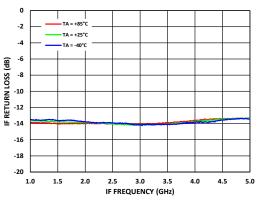


Figure 64. IF Input Return Loss vs. IF Frequency over Temperature

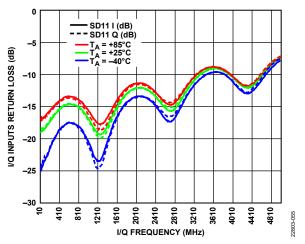


Figure 65. I/Q Inputs Return Loss vs. I/Q Frequency, Differential over Temperature (SD11 Is Differential Return Loss)

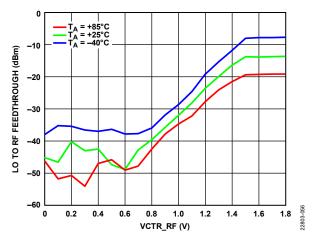


Figure 66. LO to RF Feedthrough vs. VCTR_RF , Uncalibrated over Temperature, LO Frequency = 29 GHz

Data Sheet

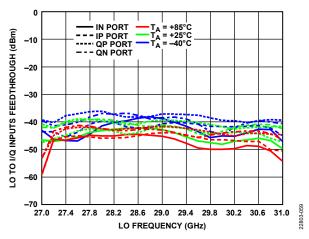


Figure 67. LO to I/Q Inputs Feedthrough vs. LO Frequency, Uncalibrated over Temperature

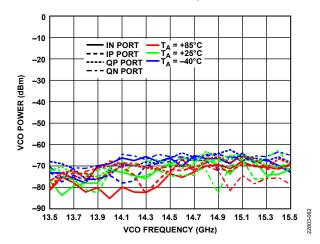


Figure 68. VCO Power vs. VCO Frequency over Temperature, Uncalibrated

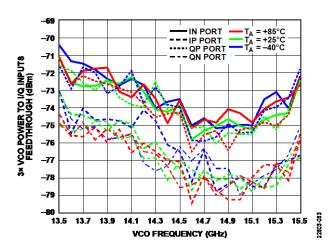


Figure 69. 3× VCO to I/Q Inputs Feedthrough vs. VCO Frequency over Temperature, Uncalibrated

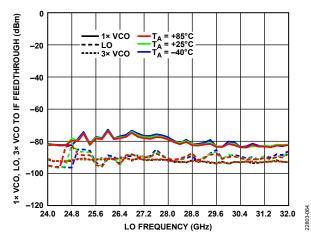


Figure 70. 1× VCO, LO, 3× VCO to IF Feedthrough vs. LO Frequency over Temperature

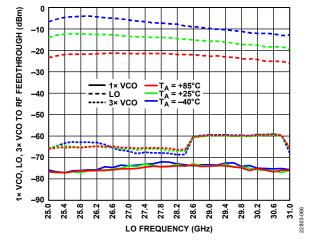


Figure 71. 1× VCO, LO, 3× VCO to RF Feedthrough vs. LO Frequency over Temperature, Uncalibrated

VCO AND PLL

 $VCC_DRV = VCC_AMP = VCC2_DRV = 4 V, VCC_IF = VCC2_IF = VCC_VVA = VCC_MIXER = VCC_DOUBLER = VCC_VCO = VCC_DIV = VCC_LDO = VCC_CP = 3.3 V, VCC_1P8V = 1.8 V, REF_IN power = 8 dBm, REF_IN frequency = 200 MHz T_A = +25°C, -40°C, and +85°C, VCTR_RF = 1.8 V, and VCTR_IF = 0 V, unless otherwise noted.$

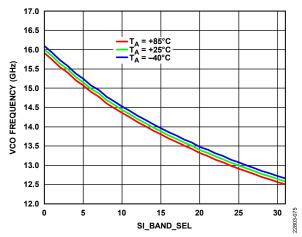


Figure 72. VCO Frequency vs. SI_BAND_SEL, Open Loop, over Temperature, VTUNE = 1.4 V

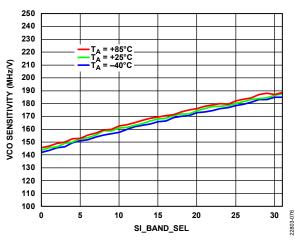


Figure 73. VCO Sensitivity vs. SI_BAND_SEL, Open Loop, over Temperatures, VTUNE = 1.4 V

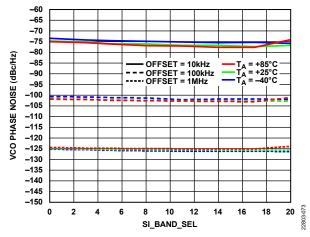


Figure 74. VCO Phase Noise vs. SI_BAND_SEL, over Temperature,

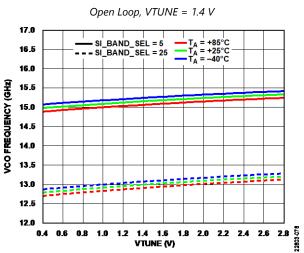


Figure 75. VCO Frequency vs. VTUNE, Open Loop over Temperature, SI_BAND_SEL = 5 and 25

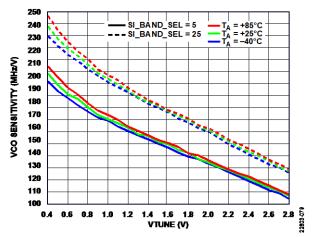


Figure 76. VCO Sensitivity vs. VTUNE, Open Loop over Temperature, SI_BAND_SEL = 5 and 25

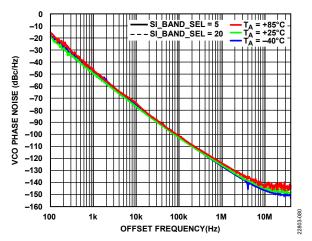


Figure 77. VCO Phase Noise vs. Offset Frequency over Temperature,

Data Sheet

Open Loop, VTUNE = 1.4 V, SI_BAND_SEL = 5 and 20

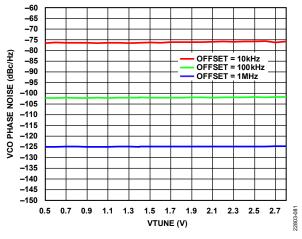


Figure 78. VCO Phase Noise vs. VTUNE for Various Offsets, Open Loop, $T_A = 25$ °C

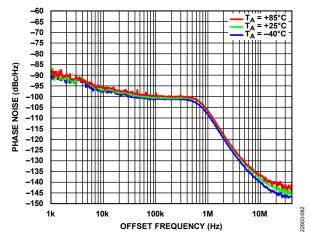


Figure 79. Phase Noise vs. Offset Frequency over Temperature, R_WORD = 2, CP_CURRENT = 4.2 mA, LO Frequency = 30 GHz

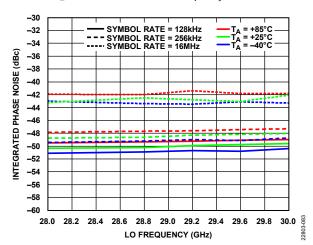


Figure 80. Integrated Phase Noise vs. LO Frequency over Temperature, R_WORD = 2, CP_CURRENT = 4.2 mA, Integrated from 1% to 50% of the Symbol Rate

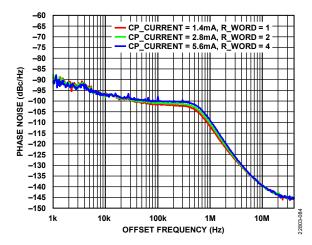


Figure 81. Phase Noise vs. Offset Frequency, LO Frequency = 27.2 GHz for Various CP_CURRENT and R_WORD Settings

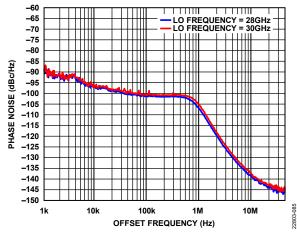


Figure 82. Phase Noise vs. Offset Frequency, R_WORD = 2, CP_CURRENT = 4.2 mA, LO Frequency = 28 GHz and 30 GHz

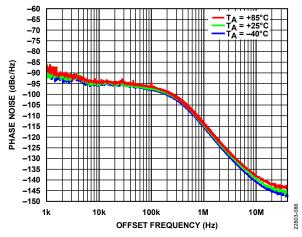


Figure 83. Phase Noise vs. Offset Frequency over Temperature, LO Frequency = 26.8 GHz, R_WORD = 4, CP_CURRENT = 2.1 mA

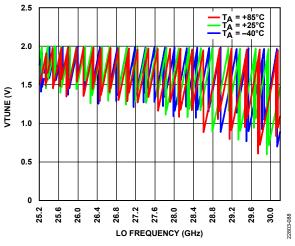


Figure 84. VTUNE vs. LO Frequency over Temperature

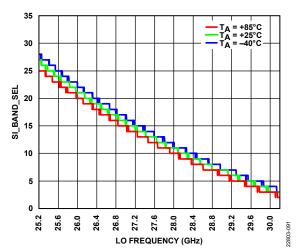


Figure 85. SI_BAND_SEL vs. LO Frequency over Temperature, VTUNE Temperature Calibration Disabled

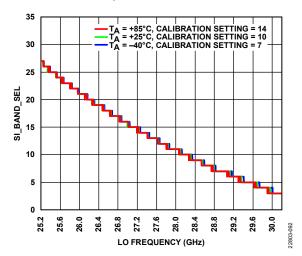


Figure 86. SI_BAND_SEL vs. LO Frequency over Temperature and Various Calibration Settings, VTUNE Temperature Calibration Enabled

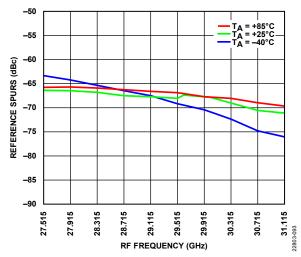


Figure 87. Reference Spurs vs. RF Frequency over Temperature, IF Mode, R_WORD = 4, CP_CURRENT = 2.1 mA, VCTR_IF = 0 V, P_{OUT} = 10 dBm

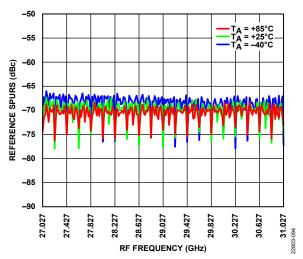


Figure 88. Reference Spurs vs. RF Frequency over Temperature, I/QMode, R_WORD = 2, CP_CURRENT = 2.1 mA, P_{OUT} = 10 dBm

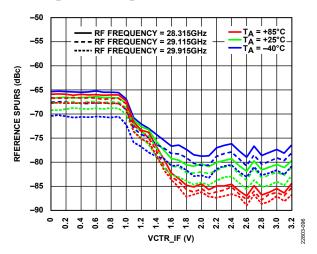


Figure 89. Reference Spurs vs. VCTR_IF over Temperature and Various RF Frequencies, IF Mode, R_WORD = 4, CP_CURRENT = 2.1 mA

UPCONVERTER M × N SPURIOUS PERFORMANCE

Mixer spurious products are measured in dBc from the RF output power level.

For IF mode, spurious frequencies are calculated by

 $|(M \times IF) + (N \times LO)|$

For I/Q mode, spurious frequencies are calculated by

 $|(M \times I/Q) + (N \times LO)|$

IF Mode

IF frequency = 2715 MHz, RF frequency = 29 GHz, RF output power = 10 dBm, VCTR_RF = 1.8 V, and VCTR_IF = 0 V. N/A means not applicable.

| | | | N× | VCO | |
|--------|----|-------|-------|-------|-------|
| | | 0 | 1 | 2 | 3 |
| | -2 | N/A | -85.4 | -79.5 | -77.7 |
| | -1 | N/A | -84.1 | -36.9 | -79.0 |
| M × IF | 0 | -74.3 | -82.8 | -20.1 | -83.7 |
| | +1 | -83.7 | -82.4 | 0.0 | -79.3 |
| | +2 | -82.8 | -83.6 | -64.1 | -78.8 |

I/Q Mode

I/Q frequency = 25 MHz, RF frequency = 29 GHz, RF output power = 10 dBm, and VCTR_RF = 1.8 V. N/A means not applicable.

| | | N × VCO | | | |
|---------|----|---------|---------|-------|-------|
| | | 0 | 1 | 2 | 3 |
| M × I/Q | -3 | N/A | -100.1 | -69.5 | -84.9 |
| | -2 | N/A | -95.6 | -85.8 | -96.5 |
| | -1 | N/A | -91.268 | -27.6 | -88.0 |
| | 0 | N/A | -89.4 | -31.3 | -80.9 |
| | +1 | -76.1 | -84.1 | 0.0 | -94.4 |
| | +2 | -96.9 | -94.6 | -51.2 | -92.4 |
| | +3 | -94.4 | -98.3 | -64.0 | -93.0 |

THEORY OF OPERATION

The ADMV4530 integrates a fractional-N PLL, VCO, internal 2× multiplier, and I/Q mixer. The fractional-N PLL locks the VCO to a precise reference input signal for low noise operation. The VCO signal is then multiplied by the internal 2× multiplier to generate the necessary LO signal for the I/Q mixer. The I/Q mixer can operate with either differential baseband I/Q inputs or a single-ended IF input. The functionality of the various blocks within the ADMV4530 follows within this section.

SPI CONFIGURATION

The SPI of the ADMV4530 allows configuration of the device for specific functions or operations via the 4-pin SPI port. This interface provides users with added flexibility and customization. The SPI consists of four control lines: SCLK, SDI, SDO, and CS. The ADMV4530 protocol consists of a write/read bit followed by 15 register address bits and 8 data bits. The address field and data field are organized MSB first and end with the LSB.

For a write operation, set the MSB to 0, and for a read operation, set the MSB to 1. The write cycle must be sampled on the rising edge of SCLK. The 24 bits of the serial write address and data are shifted in on the SDI control line, MSB to LSB. The ADMV4530 input logic level for the write cycle supports a 3.3 V interface.

For a read cycle, the R/W bit and the 15 bits of address shift in on the rising edge of SCLK on the SDI control line. Then, 8 bits of serial read data shift out on the SDO control line, MSB first, on the falling edge of SCLK. The output logic level for a read cycle is 3.3 V. The output drivers of the SDO are enabled after the last rising edge of SCLK of the instruction cycle and remain active until the end of the read cycle. In a read operation, when $\overline{\text{CS}}$ is deasserted, SDO returns to high impedance until the next read transaction. The $\overline{\text{CS}}$ is active low and must be deasserted at the end of the write or read sequence.

An active low input on CS starts and gates a communication cycle. The CS pin allows more than one device to be used on the same serial communications lines. The SDO pin goes to a high impedance state when the CS input is high. During the communication cycle, the chip select must stay low. The SPI communications protocol follows the Analog Devices, Inc., SPI standard. For more information, see the ADI-SPI Serial Control Interface Standard (Rev 1.0).

REGISTER MAP SECTIONS

The ADMV4530 consists of three register map sections. The first section spans from Register 0x000 through Register 0x00D and follows the standard Analog Devices SPI protocol, which includes protocol setup and device identification registers. The second register map section starts at Register 0x010 through Register 0x07C and contains all of the relevant PLL control registers. The third register map section starts at Register 0x100 through Register 0x100 through control registers. To read back the register values from the

first and third sections, the REG_PAGE_SEL bits in Register 0x117 must be set to 1, and to read back from the PLL section, the REG_PAGE_SEL bits in Register 0x117 must be set to 0.

DOUBLE BUFFERED REGISTERS

The PLL inside the ADMV4530 contains several double buffered bit fields that take effect only after a write to the lower portion of the N counter integer value (Register 0x010). This register applies any changes to these double buffered bit fields and initiates the autocalibration routine. The following is a list of the double buffered bit fields and their corresponding registers:

- REF_X2_EN (Register 0x022)
- RDIV2 (Register 0x022)
- R_WORD (Register 0x01F)
- CP_CURRENT (Register 0x01E)
- FRAC2WORD (Register 0x017 and Register 0x018)
- FRAC1WORD (Register 0x014 through Register 0x017)
- MOD2WORD (Register 0x019 and Register 0x01A)
- BIT_INTEGER_WORD (Register 0x010 and Register 0x011)

START-UP INITIALIZATION SEQUENCE

Upon powering up or resetting the ADMV4530, it is recommended to program the register map in reverse order, starting with the highest register number first. The reverse order ensures that the double buffered registers are programmed prior to initiating the autocalibration routine and that all PLL control settings are in their correct state. The recommended values of each register are shown in both the Register Summary section and the Register Details section. The following describes the recommended programming sequence:

- 1. Program Register 0x000 to a value of 0x18 to enable the SDO pin.
- 2. Program Register 0x117 to a value of 0x4C to enable reading from the mixer section of the register map.
- 3. Program Register 0x100 through Register 0x119 in reverse order based upon the desired mixer settings.
- 4. Program Register 0x117 to a value of 0x0C to enable reading from the PLL section of the register map.
- 5. Program Register 0x010 through Register 0x07C in reverse order based upon the desired PLL settings.

FREQUENCY UPDATE SEQUENCE

After the initialization sequence is performed, the output frequency can be updated by programming Register 0x010 through Register 0x01A in reverse order.

REFERENCE INPUT

Figure 91 shows the single-ended reference input stage. There is an internal reference multiply by 2 block (×2 doubler) that allows generation of higher f_{PFD}. A higher f_{PFD} is useful for improving overall system phase noise performance. Typically, doubling the fPFD improves the in band phase noise performance by up to 3 dBc/Hz. Use the REF_X2_EN bit (Register 0x022, Bit 5) to enable the reference doubler, which toggles the SW1 switch, shown in Figure 91.

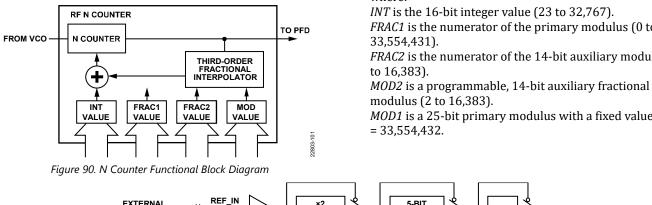
Following the reference doubler block, there are two frequency dividers: a 5-bit R counter (1 to 32 allowed) and a divide by 2 block. These dividers allow the input REF frequency to be divided down to produce lower f_{PFD} that helps minimize fractional-N integer boundary spurs at the output.

Use the R_WORD bits (Bits[4:0]) in Register 0x01F to set the R counter. If the R_WORD = 1, the SW2 switch is in the position shown in Figure 91. Otherwise, the SW2 switch toggles to use the R counter. Additionally, R_WORD = 0 corresponds to a divide by 32 value for the R counter. To enable the reference divide by 2 block, use the RDIV2 bit (Register 0x022, Bit 4) which toggles the SW3 switch, shown in Figure 91.

N COUNTER

The N counter allows a division ratio in the PLL feedback path from the VCO. Note that the VCO signal is multiplied by 2 to achieve the LO frequency at the input of the mixer. The division ratio is determined by using the Integer N (INT), fractional-N (FRAC), and modulus (MOD) values that this counter comprises. The applicable registers for setting the INT, FRAC, and MOD values are Register 0x010 to Register 0x01A.

0.01µF



DOUBLER

Figure 91. Reference Input Path Block Diagram

SW1

PRESCALER AND PRESCALER BIAS

There is two prescalers prior to the N counter, the 4/5 prescaler and the 8/9 prescaler. During operation, only one prescaler can be selected, using the PRE_SEL bit (Register 0x012, Bit 5). The 8/9 prescaler is currently not supported. Only use the 4/5 prescaler.

There is bias control for the prescaler, using the RF_PBS bits (Register 0x027, Bits[1:0]). For temperature less than or equal to 0°C, set these bits to value 1. For temperature greater than 0°C, set these bits to value 2.

INT, FRAC, MOD, AND R COUNTER RELATIONSHIP

The INT, FRAC, and MOD values, in conjunction with the reference path, make it possible to generate VCO frequencies spaced by fractions of the f_{PFD}. To calculate f_{PFD}, use the REF IN frequency and the reference path configuration parameters as follows:

$$f_{PFD} = REF_{IN}$$
 Frequency $\times \frac{1+D}{R \times (1+T)}$

where:

D is the reference doubler bit (0 or 1). *R* is the reference divide ratio of the binary, 5-bit programmable counter (1 to 32). *T* is the reference divide by 2 bit (0 or 1).

To calculate the VCO frequency (fvco), use the following equation:

$$f_{VCO} = f_{LO}/2 = f_{PFD} \times N$$

where:

 f_{L0} is the frequency of the LO driving the mixer. *N* is the desired value of the N counter.

The N counter value is defined by the following:

$$N = INT + \frac{FRAC1 + \frac{FRAC2}{MOD2}}{MOD1}$$

where:

5-BIT

R COUNTER

SW2

FRAC1 is the numerator of the primary modulus (0 to

FRAC2 is the numerator of the 14-bit auxiliary modulus (0

÷2

MOD1 is a 25-bit primary modulus with a fixed value of 2²⁵

SW3

These calculations result in a low frequency resolution with no residual frequency error. To apply the previous equation, perform the following steps:

- 1. Calculate N by dividing f_{VCO}/f_{PFD} . The integer value of this number forms INT.
- 2. Subtract INT from the full N value.
- 3. Multiply the remainder by 2²⁵. The integer value of this number forms FRAC1.
- 4. Calculate MOD2 based on the channel spacing (f_{CHSP}) by using the following equation:

 $MOD2 = (f_{PFD}/(GCD(f_{PFD}, f_{CHSP})))$

where:

 f_{CHSP} is the desired channel spacing frequency. GCD(f_{PFD} , f_{CHSP}) is the greatest common divisor of the PFD frequency and the channel spacing frequency.

5. Calculate FRAC2 by using the following equation:

 $FRAC2 = ((N - INT) \times 2^{25} - FRAC1) \times MOD2$

The FRAC2 and MOD2 fraction result in outputs with zero frequency error for channel spacing when the following is true:

 $(f_{PFD}/(\text{GCD}(f_{PFD}, f_{CHSP})) = MOD2 < 16,383$

If zero frequency error is not required, the MOD1 and MOD2 denominators operate together to create a 39bit resolution modulus.

INT N MODE

When FRAC1 and FRAC2 are equal to 0, the synthesizer operates in Integer N mode. It is recommended to set the SD_PD bit (Register 0x02B, Bit 0) to 1 to disable the Σ - Δ modulators (SDMs), which improves the in band phase noise and reduces any additional Σ - Δ noise.

PHASE FREQUENCY DETECTOR AND CHARGE PUMP

The phase frequency detector takes inputs from the R counter and N counter to produce an output that is proportional to the phase and frequency differences between these counters. This proportional information is then output to a charge pump circuit that generates current to drive an external loop filter that is then used to appropriately increase or decrease the VTUNE tuning voltage.

Figure 92 shows a simplified schematic of the phase frequency detector and charge pump. Note that the phase frequency detector includes a fixed delay element that is used to ensure that there is no dead zone in the phase frequency detector transfer function for consistent reference spur levels.

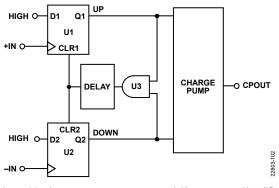


Figure 92. Phase Frequency Detector and Charge Pump Simplified Schematic

LOOP FILTER

Defining a loop filter for a PLL is dependent on several dynamics, such as the f_{PFD} , the N counter value, the K_{VCO} , and the selected charge pump current (I_{CP}). A higher f_{PFD} has the advantage of lowering in band phase noise performance at the expense of integer boundary spur levels when operating in fractional-N mode. Consequently, a lower f_{PFD} can allow the PLL to operate in integer N mode, which can eliminate integer boundary spurs at the expense of higher in band phase noise performance. Given the trade-offs, care must be taken with frequency planning and f_{PFD} selection to ensure the appropriate in band phase noise performance is met with acceptable spur levels for the end application.

The loop filter, as implemented using one of the ADMV4530 evaluation boards (see the Ordering Guide section), is a third-order passive filter, as shown in Figure 93. The filter is designed with the following simulation input parameters: $f_{PFD} = 100 \text{ MHz}$, $K_{VCO} = 155 \text{ MHz}/V$, $f_{VCO} = 15 \text{ GHz}$, and $I_{CP} = 4.2 \text{ mA}$. The resulting loop filter bandwidth and phase margin are 540 kHz and 55°, respectively, for the following component values: C1 = 150 pF, C2 = 15 nF, C3 = 20 pF, C4 = do not install (DNI), R1 = 910 Ω , R2 = 910 Ω , and R3 = 0 Ω . For additional guidance with loop filter simulations on the ADMV4530, contact Analog Devices for Technical Support.

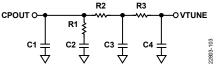


Figure 93. Recommended Loop Filter

CHARGE PUMP CURRENT SETUP

For a specifically designed loop filter, set the I_{CP} by adjusting the CP_CURRENT value in Bits[7:4], Register 0x01E. Calculate I_{CP} by using the following the equation:

 $I_{CP} = (CP_CURRENT + 1) \times 350 \,\mu\text{A}$

where *CP_CURRENT* is an integer value (0 to 15).

The default value for a 100 MHz f_{PFD} for CP_CURRENT = 11, which yields a current of 4.2 mA. The applicable range is 0.35 mA to 5.6 mA, with 0.35 mA steps.

To change the f_{PFD} , if no change has been made to the existing loop filter components, it is recommended to scale I_{CP} by using the following equation:

$$I_{CP(NEW)} = \frac{I_{CP(DEFAULT)} \times f_{PFD(DEFAULT)}}{f_{PFD(NEW)}}$$

where:

ICP (NEW) is the new desired ICP. *ICP (DEFAULT)* is the default ICP. *fPFD (DEFAULT)* is the default fPFD. *fPFD (NEW)* is the new desired fPFD.

When $I_{CP (NEW)}$ is obtained, the CP_CURRENT value in Bits[7:4], Register 0x01E, can be updated by using the following rounding function:

$$CP_CURRENT = \text{ROUND}\left(\frac{I_{CP(NEW)}}{350\,\mu\text{A}}\right) - 1$$

where *ROUND* is the mathematical round function.

BLEED CURRENT (CP_BLEED) SETUP

The charge pump includes a binary scaled bleed current (I_{BLEED}) that is set by using the CP_BLEED value in Register 0x026. The bleed current introduces a slight phase offset in the phase frequency detector to improve integer boundary spurs and phase noise when operating in fractional-N mode. To enable the bleed current for fractional-N mode, set CP_BLEED_EN = 1 (Register 0x027, Bit 3). For integer mode, CP_BLEED_EN must be set to 0.

Generally, the optimum bleed current value is 115 (431.25 μ A), and this value provides optimal performance for most applications. However, there can be additional performance improvements by empirically determining the appropriate bleed current value from the actual measurements for the intended application. The applicable range is 0 μ A to 956.25 μ A with 3.75 μ A steps.

 $I_{BLEED} = CP_BLEED \times 3.75 \ \mu A$

where *CP_BLEED* is an integer value (0 to 255).

Figure 94 shows an example of 100 kHz offset phase noise vs. CP_BLEED.

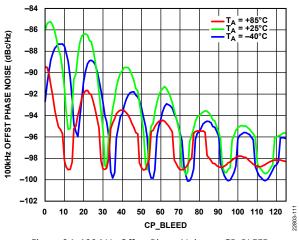


Figure 94. 100 kHz Offset Phase Noise vs. CP_BLEED, LO Frequency = 29.995 GHz, CP_CURRENT = 4.2 mA

Figure 95 is an example of 100 kHz offset phase noise vs. LO frequency with a CP_BLEED value of 115 (431.25 μ A). The CP_CURRENT was 4.2 mA and the LO frequency step size was 10 MHz. At each integer boundary, the CP_BLEED was disabled, resulting in approximately –1 dBc/Hz improvement.

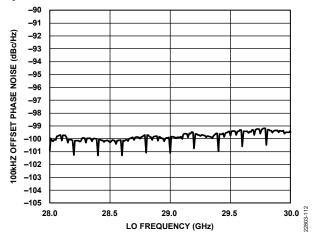


Figure 95. 100 kHz Offset Phase Noise vs. LO Frequency, CP_BLEED = 115, CP_CURRENT = 4.2 mA

MUXOUT

The output multiplexer on the ADMV4530 allows the user to access various internal signals on the chip. The MUXOUT bit field (Register 0x020, Bits[7:4]) shown in Table 34 lists the available signals. When MUXOUT_SEL (Register 0x20, Bit 3) is set to 1, the MUXOUT signal is present on the SDO output pin. Otherwise, the SDO pin is configured for SPI data output.

DIGITAL LOCK DETECT

A digital lock detect function is available on the SDO pin when both the MUXOUT and MUXOUT_SEL bits are set to 1. The digital lock detect function is also available by reading the LD_READBACK bit (Register 0x07C, Bit 0). A logic high indicates that the digital lock detect has declared the PLL is locked.

The digital lock detect function has some adjustable settings in Register 0x027 and Register 0x028. The LD_BIAS and LDP bits adjust an internal precision window and the LD_COUNT bits adjust the consecutive cycle count to declare PLL lock. It is recommended to keep the settings listed in the register map. For special applications, contact Analog Devices Technical Support for guidance on adjusting these settings.

VCO AUTOCALIBRATION

The internal VCO uses an internal autocalibration routine that optimizes the VCO settings for a particular frequency and allows the PLL to lock in approximately 100 μ s after the lower portion of the N counter integer value (Register 0x010) is programmed. For nominal applications, maintain the autocalibration default values in the register map (Register 0x030 to Register 0x034).

For applications where it is desirable to bypass the autocalibration routine, there are two necessary procedures. First, generate a lookup table of the resultant VCO calibration data (core and band parameters) for each desired VCO frequency. Second, bypass the autocalibration routine and manually write the lookup table values. Generate a new table for every chip because each chip is unique.

VCO CALIBRATION DATA READ BACK

To read back the VCO calibration data, load the required registers, let the device lock using autocalibration, and read the VCO parameters for each frequency. It is important to ensure that autocalibration has completed before readback. Reading back values before autocalibration has completed results in incorrect values being read. The bits used for read back include the following:

- Register 0x033, Bits[7:5], VCO_FSM_READBACK
- Register 0x06E, Bits[4:0], VCO_DATA_READBACK
- Register 0x06F, Bit 0, VCO_DATA_READBACK

The VCO_FSM_READBACK bits set what data is sent to the VCO_DATA_READBACK bits.

To read the VCO parameters, take the following steps:

- 1. Program the device to lock at the desired frequency by using the autocalibration feature. Users must wait for the device to lock.
- 2. Set VCO_FSM_READBACK = 1 to allow readback of the VCO band and the core.
- 3. Read Register 0x06F, Bit 0 to read back the current VCO core. The ADMV4530 has only one VCO core. Therefore, this value must always be 1.
- 4. Read Register 0x06E, Bits[4:0] to read back the VCO band.

Repeat Step 1 through Step 4 for each required frequency to build a lookup table of values.

VCO CALIBRATION DATA MANUAL WRITING

The VCO parameters for each required frequency force the device to the target frequency core and band without the use of autocalibration.

The bits used for writing to the VCO parameters include the following:

- Register 0x034, Bits[7:5], VCO_FSM_TEST_MODES
- Register 0x037, Bits[7:0], SI_BAND_SEL
- Register 0x038, Bits[7:4], SI_VCO_SEL

To write the VCO parameters, take the following steps:

- 1. At power-up, set up the serial port interface and initialize the device as necessary for normal operation.
- 2. Set AUTOCAL_EN = 0 (Register 0x012, Bit 6) to disable autocalibration.
- 3. Set VCO_FSM_TEST_MODES = 010 to overwrite the VCO core and band.
- 4. Program the registers, except Register 0x010, as required for the target frequency. This step is frequency dependent.
- 5. Set SI_VCO_SEL = 1. Even though the ADMV4530 has only one VCO core, it is still necessary to program this bit because this bit tells the internal finite state machine to enable the VCO.
- 6. Set SI_BAND_SEL to the desired band from the previously generated lookup table.
- 7. Write to Register 0x010. When this register is written to, the device locks to the new frequency.

Repeat Step 4 through Step 7 as required for setting the appropriate VCO frequency.

AUTOCALIBRATION LOCK TIME

The PLL lock time divides into a number of settings. The total lock time for changing frequencies is the sum of three separate times: synthesizer lock, VCO band selection, and PLL settling.

SYNTHESIZER LOCK TIMEOUT

The synthesizer lock timeout ensures that the VCO calibration digital-to-analog converter (DAC), which forces the VCO tune voltage (V_{VTUNE}), has settled to a steady value for the band select circuitry. The SYNTH_LOCK_TIMEOUT and the TIMEOUT bits select the length of time the DAC is allowed to settle to the final voltage before the VCO calibration process continues to the next phase (VCO band selection). The PFD frequency is the clock for this logic, and the duration is set by using the following equation:

(SYNTH_LOCK_TIMEOUT × 1024 + TIMEOUT)/f_{PFD}

where:

SYNTH_LOCK_TIMEOUT is programmed in Bits[4:0], Register 0x033.

TIMEOUT is programmed in Bits[7:0], Register 0x031 and Bits[1:0], Register 0x032.

The calculated time must be greater than or equal to 20 $\mu s.$

For the SYNTH_LOCK_TIMEOUT bits, the minimum value is 2, and the maximum value is 31.

For TIMEOUT, the minimum value is 2, and the maximum value is 1023.

VCO BAND SELECTION TIME

Use the VCO_BAND_DIV bits (Bits[7:0], Register 0x030) and the f_{PFD} to generate the VCO band selection clock (f_{BSC}) as follows:

 $f_{BSC} = (f_{PFD} / VCO_BAND_DIV)$

The calculated frequency must be less than 2.4 MHz.

Note that 16 clock cycles are required for one VCO core and band calibration step and the total band selection process takes 11 steps, resulting in the following equation:

11 × (16 × VCO_BAND_DIV/fPFD)

The minimum value for VCO_BAND_DIV is 1, and the maximum value is 255.

PLL SETTLING TIME

The time taken for the loop to settle is inversely proportional to the low-pass filter bandwidth.

CHIP TEMPERATURE READ BACK

Chip temperature readback can provide information regarding system temperature, which is useful for system compensation.

The ADMV4530 includes an analog-to-digital converter (ADC) that enables reading the chip temperature. The ADC clock (ADC_CLK) is generated from the phase frequency detector clock (f_{PFD}) with the following equations:

$$ADC_CLK = \frac{f_{PFD}}{((ADC_CLK_DIV \times 4) + 2)}$$

where *ADC_CLK_DIV* is stored in Register 0x035.

A valid reference signal is required to complete a conversion. Target 100 kHz for ADC_CLK and calculate ADC_CLK_DIV with the following equation:

$$ADC_CLK_DIV = ceiling\left(\frac{\left(\left(\frac{f_{PFD}}{100,000}\right) - 2\right)}{4}\right)$$

If ADC_CLK_DIV is greater than 255, set these bits to 255.

The bits used for temperature readback are the following:

- Register 0x032, Bit 2, ADC_ENABLE
- Register 0x032, Bit 3, ADC_CONVERSION
- Register 0x033, Bits[7:5], VCO_FSM_READBACK
- Register 0x06E, Bits[7:0], VCO_DATA_READBACK[7:0]
- Register 0x073, Bit 2, ADC_CLK_DISABLE

To read back the temperature, take the following steps:

- 1. Set ADC_ENABLE = 1 to enable the ADC.
- 2. Set ADC_CONVERSION = 1 to perform an ADC conversion.
- 3. Wait 16 ADC_CLK cycles.
- 4. Set VCO_FSM_READBACK = 101 (skip this step if it is already set).
- 5. Read the VCO_DATA_READBACK bits in Register 0x06E to read back the raw ADC output that corresponds to the chip temperature (RAW_TEMP).
- 6. Set ADC_CONVERSION = 0 to disable the conversion.
- Set ADC_ENABLE = 0 to disable the ADC, which prevents any spurs generated by the ADC clock. Similarly, the ADC_CLK_DISABLE bit can disable the ADC clock.

Perform Step 1 and Step 2 separately. However, Step 6 and Step 7 can be completed together.

To calculate the approximate chip temperature in Celsius (°C), use the following equation:

Chip Temperature = -115°C + *RAW_TEMP*

Data Sheet

RF OUTPUT DRIVER

As shown in the functional block diagram (see Figure 1), the ADMV4530 incorporates two driver stages along with a voltage variable attenuator (VVA) in the RF output section of the chip. The VCTR_RF pin (Pin 4) is connected to the VVA, which adjusts the RF output gain. The voltage range for the VCTR_RF pin is 0 V to 1.8 V, with a positively sloping linear region between 0.6 V to 1.5 V, as shown in Figure 8. The typical slope within linear region is 32 dB/V.

I/Q MODE MIXER SETUP

In baseband quadrature modulation mode, the input impedance of the baseband pins (IN, IP, QN, and QP) are 100 Ω differential. These inputs can be driven with a dc-coupled 100 Ω differential source. IN and IP are the differential baseband I inputs, and QN and QP are the differential baseband Q inputs. These inputs can operate from a common-mode voltage range of 0 V to 2.5 V. When operating in I/Q mode, program the following registers:

- Register 0x100 = 0x3A
- Register 0x101 = 0x78
- Register 0x102 = 0x11
- Register 0x103 = 0x5D (for 0.5 V V_{CM})
- Register 0x106 to 0x109 = 0x7F
- Register 0x115 = 0x88

When V_{CM} changes, program Register 0x103 by using the following formulas for each mode.

In I/Q mode, for V_{CM} = 0.0 V to 1.5 V, set

 $MIXER_VCM = \text{ROUND}(23.8 \times V_{CM} + 80.7).$

In I/Q mode, for V_{CM} = 1.5 V to 2.5 V, set

 $MIXER_VCM = \text{ROUND}(23.8 \times V_{CM} + 1.3).$

The I/Q mode default for $V_{CM} = 0.5$ V is MIXER_VCM = 93 = 0x5D.

I/Q MODE LO NULLING

To perform LO nulling in I/Q mode, apply a differential dc offset on the I and Q inputs. Note that LO nulling is a twostep process. When LO nulling is done on the I side, keep the Q side at V_{CM}, and when LO nulling is done on the Q side, the I side must be kept at V_{CM} or at the determined value in the first step. The optimal LO null is when settings from the I side and the Q side are combined. It is important to keep V_{CM} constant. Therefore, when a dc offset is applied on the negative input (V_{CMN}), the same offset must be applied on the positive input (V_{CMP}) in the opposite direction ($V_{CMP} \pm dc$ offset and $V_{CMN} \neq dc$ offset) to allow the average V_{CM} to hold constant to coincide with the value programmed in Register 0x103. LO nulling at a single point is optimal at that particular frequency and temperature, and the absolute level (dBm) of the LO to RF feedthrough remains the same across gain settings using the VCTR_RF input.

For example, it is possible to null LO down to -50 dBm with VCTR_RF = 1.8 V, depending on the resolution of the dc offset applied and the temperature (as shown in Figure 28 and

Figure 29), where LO nulling = 29 GHz. When LO nulling = 29 GHz, the LO to RF feedthrough is <-20 dBm over temperature, and the frequency range is from 28 GHz to 30 GHz.

I/Q MODE SIDEBAND REJECTION NULLING

In I/Q mode, use Register 0x104 or Register 0x105 to perform sideband rejection nulling. Each register has 128 settings, Bits[6:0]. Single frequency nulling allows sideband rejection to null down to -45 dBc for a particular frequency. The sideband rejection degrades to -35 dBc if the frequency or temperature changes (shown in Figure 27 and Figure 30).

IF GAIN CONTROL

As shown in the functional block diagram (see Figure 1), the ADMV4530 incorporates an IF amplifier with analog gain control. The analog voltage for this IF amplifier can either be provided by the internal AGC loop or by applying an external VCTR_IF voltage to the EXT_CAP_N (Pin 10). The voltage range for the IF amplifier gain control is 0 V to 3.3 V, with a negatively sloping linear region between 0.9 V and 2.2 V, as shown in Figure 38. The typical slope within linear region is –32 dB/V.

IF MODE MIXER SETUP

The ADMV4530 features the ability to upconvert a real IF input anywhere from 2 GHz to 3 GHz. When operating in IF mode program the following registers:

- Register 0x100 = 0x03
- Register 0x101 = 0x7D
- Register 0x102 = 0x3F
- Register 0x103 = 0x5B (this register sets V_{CM} in IF mode)
- Register 0x104 to 0x109 = 0x5F
- Register 0x115 = 0x08

When $V_{\mbox{\scriptsize CM}}$ changes, program Register 0x103 by using the following formula:

 $MIXER_VCM = \text{ROUND}(0.3 \times (128 - TARGET_MIXER_DC_OFFSET) + 80.7)$

where *TARGET_MIXER_DC_OFFSET* is the value programmed into Register 0x106 to Register 0x109.

IF MODE LO NULLING

LO nulling is performed in IF mode in a similar fashion as in I/Q mode. However, dc offset is applied through Register 0x106 to Register 0x109. Use Register 0x106 and Register 0x107 to force a dc offset on the I side, and use Register 0x108 and Register 0x109 to force a dc offset on the Q side. It is important to sweep the I and Q registers simultaneously in opposite direction so that the following are true:

(MIXER_DC_OFFSET_IP + MIXER_DC_OFFSET_IN)/2 = TARGET_MIXER_DC_OFFSET

(*MIXER_DC_OFFSET_QP* + *MIXER_DC_OFFSET_QN*)/2 = *TARGET_MIXER_DC_OFFSET*

As in I/Q mode, LO nulling is two-step process. When LO nulling on the I side, keep the Q side at the TARGET_MIXER_DC_OFFSET. When LO nulling on the Q side, keep the I side at the TARGET_MIXER_DC_OFFSET, or at the determined value from the first step. The optimal null is achieved when both settings are combined. The recommended TARGET_MIXER_DC_OFFSET value is 95 decimal (0x5F). It is recommended to keep the TARGET_MIXER_DC_OFFSET above 63. The MIXER_DC_OFFSET range for Register 0x106 to Register 0x109 is from 63 decimal to 127 decimal. The LO to RF feedthrough improves to approximately -30 dB following this procedure. When the LO is nulled at a single frequency and temperature, the LO to RF feedthrough is less than -40 dBc, and the LO to RF feedthrough is less than -25 dBc across frequency and temperature, as shown in Figure 57.

IF MODE SIDEBAND REJECTION NULLING

In IF mode, use Register 0x104 or Register 0x105 to perform sideband rejection nulling. Each register has 128 settings, Bits[6:0]. Single frequency nulling allows sideband rejection to null down to -50 dBc for a particular frequency. If the operating frequency or temperature changes, sideband rejection nulling degrades. When sideband rejection is nulled at 29 GHz, it is less than -30 dBc over temperature and the frequency range is from 28 GHz to 30 GHz (as shown in Figure 56).

APPLICATIONS INFORMATION

IF AGC CONFIGURATION

The ADMV4530 includes an AGC circuit on the IF input port. The four bit fields that control the functionality of this AGC follow:

- 1. AGC_EN (Register 0x101)
- 2. AGC_EN_OVERRIDE (Register 0x102)
- 3. IF_DET_EN_OVERRIDE (Register 0x102)
- 4. DET_RANGE (Register 0x10C)
- 5. AGC_VREF_GEN (Register 0x10D)

The AGC_EN bit enables or disables the AGC that is only truly enabled when in power-down mode. The AGC_EN_OVERRIDE and IF_DET_EN_OVERRIDE bits enable the AGC and detector regardless of the power-down mode.

The DET_RANGE bit field selects the appropriate range for the internal power detector, and the AGC_VREF_GEN bit field determines the voltage reference set point for the AGC.

Figure 96 shows an example of the output power vs. the input power level for various settings of DET_RANGE and AGC_VREF_GEN. The first number in the Figure 96 legend is the DET_RANGE setting (decimal value), and the second number in the Figure 96 legend is the AGC_VREF_GEN setting (decimal value).

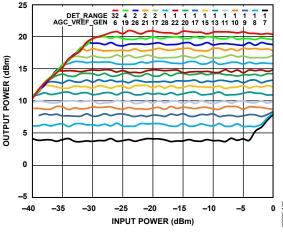


Figure 96. Power Sweep for Various AGC Settings

Figure 97 shows the output power given a –20 dBm input IF signal and sweeping the AGC voltage reference set point for various DET_RANGE settings.

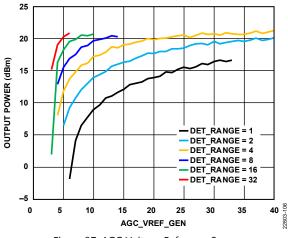


Figure 97. AGC Voltage Reference Sweep

When AGC is enabled, the AGC voltage needed for the IF gain control is accessible on the EXT_CAP_N pin (Pin 10). When the AGC is disabled, this pin functions as an input for the IF amplifier gain control.

ERROR VECTOR MAGNITUDE PERFORMANCE

The error vector magnitude performance of the ADMV4530 is measured at an RF frequency of 29.98 GHz (fractional mode, phase noise adjusted as shown in Figure 94) and an RF frequency of 30 GHz (integer mode) with a single 12 MHz, 8 quadrature phase shifting keying (QPSK) carrier in I/Q mode, 0 Hz offset, 0.2 roll-off factor, and LO and sideband rejection nulled. The measurement was performed at $T_A = 25^{\circ}C$.

Figure 98 shows the transmitter error vector magnitude vs. the output power. The transmitter has an approximately 3% error vector magnitude with an output power of 12 dBm.

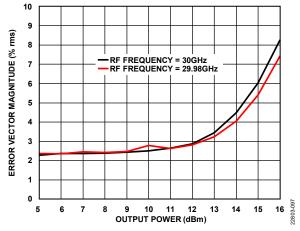


Figure 98. Error Vector Magnitude vs. Output Power, 8 QPSK Modulation, 12 MHz Bandwidth

PLL LOCK TIME IN IF AND I/Q MODE

Using the recommended autocalibration setup described in the VCO Autocalibration section, the typical autocalibration lock time is shown in Figure 99. These results reflect a VCO band selection clock (f_{BSC}) = 4 MHz.

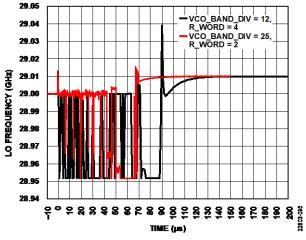


Figure 99. LO Frequency vs. Time, REF_IN Frequency = 200 MHz, f_{BSC} = 4 MHz

POWER UP AND DOWN

The ADMV4530 includes a power-down (PD) pin that when enabled turns off the mixer and output driver section of the chip but keeps the PLL and VCO active. For applications where a fast power-up time is required, this standby mode is useful for muting the RF output signal while keeping the PLL locked. Figure 100 shows the typical response time of the PD pin.

Table 8. Typical Power Consumption at $T_A = 25^{\circ}C$

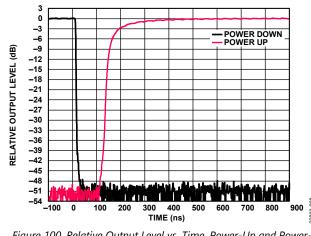


Figure 100. Relative Output Level vs. Time, Power-Up and Power-Down

The chip can be set to its lowest power state by disabling the bias for the PLL, VCO, and RF sections. To accomplish setting the chip to its lowest power state, enable the following bits:

- PLL_PD, Register 0x01E, Bit 2
- VCO_PD, Register 0x027, Bit 2
- RF_BIAS_PD, Register 0x100, Bit 7

When exiting the lowest power state and bringing the device back to nominal operating conditions, the PLL must be relocked by updating Register 0x010. Table 8 details the typical power consumption for nominal, standby, and low power conditions.

| Table 6. Typical r | ower consumption at 1 _A | | |
|--------------------|------------------------------------|--|--|
| State | Power (W) | Test Conditions/Comments | |
| Nominal | | Maximum gain | |
| I/Q Mode | 1.8 | | |
| IF Mode | 2.5 | | |
| Standby | | PD pin high | |
| I/Q Mode | 0.7 | | |
| IF Mode | 1.4 | | |
| Low Power | 0.2 | PD pin high, PLL, VCO, and RF disabled | |

REGISTER SUMMARY

N/A means not applicable, R means read, and R/W means read/write.

Table 9. Register Summary

| | | ister | Summary | 1 | 1 | | 1 | 1 | 1 | 1 | - | 1 | - |
|--------------|-------------|-----------|------------------------|-----------------------|------------------------------|------------------|----------------|--------------------|---------------|-------------------|--------------|-------------------------------|---------|
| Reg (Hex) | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Rese t | Recommende d | R/ W |
| 000 | REG000 0 | [7:0] | SOFT_RESET_ R | LSB_FIRST_R | ADDR_ ASCN_R | SDO_ ACTIVE_R | SDO_ACTIVE | ADDR_ASCN | LSB_FIRS T | SOFT_RESET | 0x00 | 0x18 | R/ W |
| 001 | REG000 1 | [7:0] | SINGLE_ INSTRUCTION | CSB_STALL | CONTROLL ER_TARGET _RB | | | RESERVED | | | 0x00 | 0x00 | R/ W |
| 003 | REG000 3 | [7:0] | | RESER | VED | | | CHIP_ | TYPE | | 0x01 | N/A | R |
| 004 | REG000 4 | [7:0] | | | | PRODUC | T_ID[7:0] | | | | 0x21 | N/A | R |
| 005 | REG000 5 | [7:0] | | | | PRODUCT | _ID[15:8] | | | | 0x00 | N/A | R |
| 00A | REG000 A | [7:0] | | | | SCRATC | H_PAD | | | | 0x00 | User defined | R/ W |
| 00B | REG000 B | [7:0] | | | | SPI_ | REV | | | | 0x01 | N/A | R |
| 00C | REG000 C | [7:0] | | | | VENDOF | R_ID[7:0] | | | | 0x56 | N/A | R |
| 00D | REG000 D | [7:0] | | | | VENDOR | _ID[15:8] | | | | 0x04 | N/A | R |
| 010 | REG001 0 | [7:0] | | BIT_INTEGER_WORD[7:0] | | | | | | 0x80 | User defined | R/ W | |
| 011 | REG001 1 | [7:0] | | | | BIT_INTEGER | WORD[15:8] | | | | 0x00 | User defined | R/ W |
| 012 | REG001 2 | [7:0] | RESERVED | AUTOCAL_E N | PRE_SEL | | | RESERVED | | | 0x00 | 4/5: 0x40 | R/ W |
| 014 | REG001 4 | [7:0] | | FRAC1WORD[7:0] | | | | | | | 0x00 | User defined | R/ W |
| 015 | REG001 5 | [7:0] | | FRAC1WORD[15:8] | | | | | | 0x00 | User defined | R/ W | |
| 016 | REG001 6 | [7:0] | | | | FRAC1WO | RD[23:16] | | | | 0x00 | User defined | R/ W |
| 017 | REG001 7 | [7:0] | | | FR | AC2WORD[6:0] | l | | | FRAC1WORD[2 4] | 0x00 | User defined | R/ W |
| 018 | REG001 8 | [7:0] | RESERVED | | | FI | RAC2WORD[13: | 7] | | | 0x00 | User defined | R/ W |
| 019 | REG001 9 | [7:0] | | | | MOD2W | ORD[7:0] | | | | 0x00 | User defined | R/ W |
| 01A | REG001 A | [7:0] | RESE | RVED | | | MOD2W0 | ORD[13:8] | | | 0x00 | User defined | R/ W |
| 01B | REG001 B | [7:0] | | | | PHASE_W | ORD[7:0] | | | | 0x00 | 0x09 | R/ W |
| 01C | REG001 C | [7:0] | | | | PHASE_W | ORD[15:8] | | | | 0x00 | 0x00 | R/ W |
| 01D | REG001 D | [7:0] | | | | PHASE_WC | DRD[23:16] | | | | 0x00 | 0x80 | R/ W |
| 01E | REG001 E | [7:0] | | CP_CUR | RENT | | PD_POL | PLL_PD | RESERVE D | CNTR_RESET | 0x00 | 2.1 mA: 0x58, 4.2 mA: 0xB8 | R/ W |
| 01F | REG001 F | [7:0] | | RESERVED | | | | R_WORD | 1 | | 0x00 | ≥0x01 | R/ W |
| 020 | REG002 0 | [7:0] | | MUX | DUT | | MUXOUT_SE L | MUXOUT_ LEV_SEL | RE | SERVED | 0x00 | Data: 0x14, mux: 0x1C | R/ W |
| 022 | REG002 2 | [7:0] | RESE | RVED | REF_X2_EN | RDIV2 | | RESEF | RVED | | 0x00 | User defined | R/ W |
| 025 | REG002 5 | [7:0] | | | RESE | RVED | | | VCO | _POUT_SEL | 0x00 | 0x03 | R/ W |

Data Sheet

ADMV4530

| Reg (Hex) | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Rese t | Recommende d | R/ W |
|--------------|-------------|----------------|-----------------|-------------------------------------|-----------------------|-------------------|------------------------|----------------------|--------------|-------------|--------------|--|---------|
| 026 | REG002 6 | [7:0 | | | | CP_B | LEED | | | | 0x00 | 0x73 | R/ W |
| 027 | REG002 7 |] [7:0] | LD_E | BIAS | LDP | CP_BLEED_ GATE | CP_BLEED_EN | VCO_PD | F | RF_PBS | 0x00 | TA ≤ 0°C: FRAC: 0xC9, INT: 0xE1 TA > 0°C: | R/ W |
| | | | | | | | | | | 1 | | FRAC: 0xCA, INT: 0xE2 | |
| 028 | REG002 8 | [7:0] | | | RESERVED | | | LD_CC | DUNT | LOL_EN | 0x00 | 0x03 | R/ W |
| 02A | REG002 A | [7:0] | RESE | RVED | CP_BLEED_ POL | RESERVED | CSB_SYNC | | RESERVED |) | 0x00 | 0x00 | R/ W |
| 02B | REG002 B | [7:0] | RESE | RVED | LSB_P1 | VAR_MOD_E N | RESERVED | SD_MASK_ RESET_EN | RESERVE D | SD_PD | 0x00 | FRAC: 0x10, INT: 0x01 | R/ W |
| 02C | REG002 C | [7:0] | | | | RESERVED | | 1 | | DISABLE_ALC | 0x00 | 0x01 | R/ W |
| 030 | REG003 0 | [7:0] | | | | VCO_BA | ND_DIV | | | 1 | 0x00 | User defined | R/ W |
| 031 | REG003 1 | [7:0] | | | | TIMEO | JT[7:0] | | | | 0x00 | User defined | R/ W |
| 032 | REG003 2 | [7:0] | ADC_MUX_SE L | RESERVED | ADC_ FAST_CON V | ADC_ CTS_CONV | ADC_ CONVERSIO N | ADC_ENABL E | TIM | EOUT[9:8] | 0x00 | User defined | R/ W |
| 033 | REG003 3 | [7:0] | VCC | VCO_FSM_READBACK SYNTH_LOCK_TIMEOUT | | | | | | 0x00 | User defined | R/ W | |
| 034 | REG003 4 | [7:0] | VCO_ | FSM_TEST_MO | DES | | VC | O_ALC_TIMEO | UT | | 0x00 | 0x80 | R/ W |
| 035 | REG003 5 | [7:0] | | | | ADC_CLK | DIVIDER | | | | 0x00 | 0xFF | R/ W |
| 036 | REG003 6 | [7:0] | | | | ICP_ADJUS | T_OFFSET | | | | 0x00 | 0x30 | R/ W |
| 037 | REG003 7 | [7:0] | | | | SI_BAN | ID_SEL | | | | 0x00 | 0x00 | R/ W |
| 038 | REG003 8 | [7:0] | | SI_VCC | D_SEL | | | RESE | RVED | | 0x00 | 0x00 | R/ W |
| 039 | REG003 9 | [7:0] | RESERVED | VCO_ | FSM_TEST_MU | JX_SEL | | SI_VTUNE | _CAL_SET | | 0x00 | 0x07 | R/ W |
| 03A | REG003 A | [7:0 | | | | ADC_C | FFSET | | | | 0x00 | 0x55 | R/ W |
| 03E | REG003 E | [7:0 | | RESER | VED | | CP_TI | MODE | RE | SERVED | 0x00 | 0x0C | R/ W |
| 06E | REG006 E | [7:0 | | | | VCO_DATA_RE | ADBACK[7:0] | | | | 0x00 | N/A | R |
| 06F | REG006 F | [7:0] | | | | VCO_DATA_RE | ADBACK[15:8] | | | | 0x00 | N/A | R |
| 073 | REG007 3 |] [7:0] | | | RESERVED | | | ADC_CLK_ DISABLE | NDIV_PD | LD_COUNT_SE | 0x00 | 0x00 | R/ W |
| 07C | REG007 C | [7:0] | | | | RESERVED | | | 1 | LD_READBACK | 0x00 | N/A | R |

| Reg (Hex) | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Rese t | Recommende d | R/ W |
|--------------|-------------|-----------|------------------------|---------------------|--------------------|---|--------------|-----------|--------------|-------------------------------------|-----------|-------------------------------------|---------|
| 100 | REG010 0 | [7:0] | RF_BIAS_PD | RESERVED | | IFAMP_PD RESERVED_0 MIXER_ IF_SW_EN SW_CFG | | | 0x03 | I/Q mode: 0x3A, IF mode: 0x03 | R/ W | | |
| 101 | REG010 1 | [7:0] | | RESE | RVED | | MIXER_EN | IF_DET_EN | RESERVE D | AGC_EN | 0x7F | I/Q mode: 0x78, IF mode: 0x7D | R/ W |
| 102 | REG010 2 | [7:0] | IF_DET_EN_ OVERRIDE | AGC_EN_ OVERRIDE | IF_VVA_CF G | RESERVED | | IFAMP_EN | | RESERVED | 0x3F | I/Q mode: 0x11, IF mode: 0x3F | R/ W |
| 103 | REG010 3 | [7:0] | RESERVED | | | | MIXER_VCM | | | | 0x51 | I/Q mode: 0x5D, IF mode: 0x5B | R/ W |
| 104 | REG010 4 | [7:0] | RESERVED | | PHASE_ADJ_I | | | | | 0x5F | 0x5F | R/ W | |
| 105 | REG010 5 | [7:0] | RESERVED | | PHASE_ADJ_Q | | | | | | 0x5F | 0x5F | R/ W |
| 106 | REG010 6 | [7:0] | RESERVED | | MIXER_DC_OFFSET_IP | | | | | | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/ W |
| 107 | REG010 7 | [7:0] | RESERVED | | MIXER_DC_OFFSET_IN | | | | | | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/ W |
| 108 | REG010 8 | [7:0] | RESERVED | | | MI | XER_DC_OFFSE | T_QP | | | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/ W |
| 109 | REG010 9 | [7:0] | RESERVED | | | MD | KER_DC_OFFSE | T_QN | | | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/ W |
| 10C | REG010 C | [7:0] | RESERVED | | | | DET_RANGE | | | | 0x08 | User defined | R/ W |
| 10D | REG010 D | [7:0] | RESERVED | | | | AGC_VREF_GE | N | | | 0x69 | User defined | R/ W |
| 115 | REG011 5 | [7:0] | IF_TERM | | | | RESERVED | | | | 0x08 | I/Q mode: 0x88, IF mode: 0x08 | R/ W |
| 116 | REG011 6 | [7:0] | | RESE | RVED | | | IF_FII | TER | | 0x00 | 0x00 | R/ W |
| 117 | REG011 7 | [7:0] | REG_P/ | AGE_SEL | | | RESI | ERVED | | | 0x4C | PLL: 0x0C, mixer: 0x4C | R/ W |
| 119 | REG011 9 | [7:0] | RESE | ERVED | START_ POLY_CAL | CAL_ POLY_EN | | RESE | RVED | | 0x08 | 0x08 | R/ W |

REGISTER DETAILS

Address: 0x000, Reset: 0x00, Name: REG0000

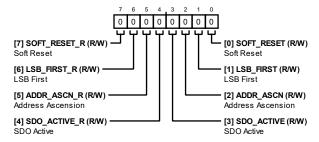


Table 10. Bit Descriptions for REG0000

| Bits | Bit Name | Description | Reset | Recommended | Access |
|------|--------------|-------------------------|-------|-------------|--------|
| 7 | SOFT_RESET_R | Soft Reset | 0x0 | 0x0 | R/W |
| | | 0: reset not asserted | | | |
| | | 1: reset asserted | | | |
| 6 | LSB_FIRST_R | LSB First | 0x0 | 0x0 | R/W |
| | | 0: MSB first | | | |
| | | 1: LSB first | | | |
| 5 | ADDR_ASCN_R | Address Ascension | 0x0 | 0x0 | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| 4 | SDO_ACTIVE_R | SDO Active | 0x0 | 0x1 | R/W |
| | | 0: disable (3-wire SPI) | | | |
| | | 1: enable (4-wire SPI) | | | |
| 3 | SDO_ACTIVE | SDO Active | 0x0 | 0x1 | R/W |
| | | 0: disable (3-wire SPI) | | | |
| | | 1: enable (4-wire SPI) | | | |
| 2 | ADDR_ASCN | Address Ascension | 0x0 | 0x0 | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| 1 | LSB_FIRST | LSB First | 0x0 | 0x0 | R/W |
| | | 0: MSB first | | | |
| | | 1: LSB first | | | |
| 0 | SOFT_RESET | Soft Reset | 0x0 | 0x0 | R/W |
| | | 0: reset not asserted | | | |
| | | 1: reset asserted | | | |

Address: 0x001, Reset: 0x00, Name: REG0001

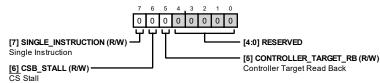


Table 11. Bit Descriptions for REG0001

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------------|---|-------|-------------|--------|
| 7 | SINGLE_INSTRUCTION | Single Instruction | 0x0 | 0x0 | R/W |
| | | 0: enable streaming | | | |
| | | 1: disable streaming (regardless of \overline{CS}) | | | |
| 6 | CSB_STALL | CS Stall | 0x0 | 0x0 | R/W |
| 5 | CONTROLLER_TARGET_RB | Controller Target Read Back | 0x0 | 0x0 | R/W |
| [4:0] | RESERVED | Reserved | 0x0 | 0x0 | R/W |

Address: 0x003, Reset: 0x01, Name: REG0003

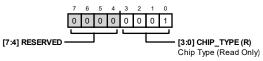
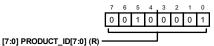


Table 12. Bit Descriptions for REG0003

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|-----------------------|-------|-------------|--------|
| [7:4] | RESERVED | Reserved | 0x0 | N/A | R |
| [3:0] | CHIP_TYPE | Chip Type (Read Only) | 0x1 | N/A | R |

Address: 0x004, Reset: 0x21, Name: REG0004



Product ID

Table 13. Bit Descriptions for REG0004

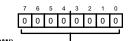
| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|-------------|-------|-------------|--------|
| [7:0] | PRODUCT_ID[7:0] | Product ID | 0x21 | N/A | R |

Address: 0x005, Reset: 0x00, Name: REG0005

Table 14. Bit Descriptions for REG0005

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------|-------------|-------|-------------|--------|
| [7:0] | PRODUCT_ID[15:8] | Product ID | 0x0 | N/A | R |

Address: 0x00A, Reset: 0x00, Name: REG000A



[7:0] SCRATCH_PAD (R/W) Scratch Pad

Table 15. Bit Descriptions for REG000A

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-------------|-------------|-------|--------------|--------|
| [7:0] | SCRATCH_PAD | Scratch Pad | 0x0 | User defined | R/W |

Address: 0x00B, Reset: 0x01, Name: REG000B

| 6 | 7 |
|-------|-----|
| 5 | 6 5 |

Table 16. Bit Descriptions for REG000B

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------|---------------------------|-------|-------------|--------|
| [7:0] | SPI_REV | SPI Register Map Revision | 0x1 | N/A | R |

Address: 0x00C, Reset: 0x56, Name: REG000C

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|-------------|---|---|---|---|---|---|---|---|--|
| | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | |
| | | - | - | - | | | | | |
| ID[7:01 (D) | | | | | | | | | |

Table 17. Bit Descriptions for REG000C

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|-------------|-------|-------------|--------|
| [7:0] | VENDOR_ID[7:0] | Vendor ID | 0x56 | N/A | R |

Address: 0x00D, Reset: 0x04, Name: REG000D

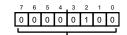


Table 18. Bit Descriptions for REG000D

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|-------------|-------|-------------|--------|
| [7:0] | VENDOR_ID[15:8] | Vendor ID | 0x4 | N/A | R |

Address: 0x010, Reset: 0x80, Name: REG0010

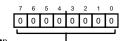
1 0 0 0 0 0 0 0

[7:0] BIT_INTEGER_WORD[7:0] (R/W) — 16-Bit Integer Word

Table 19. Bit Descriptions for REG0010

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------------|---|-------|--------------|--------|
| [7:0] | BIT_INTEGER_WORD[7:0] | 16-Bit Integer Word. Sets the integer value of N. Updates | 0x80 | User defined | R/W |
| | | to the PLL N counter, including FRAC1, FRAC2, and MOD2, | | | |
| | | are double buffered by this bit field. | | | |

Address: 0x011, Reset: 0x00, Name: REG0011



[7:0] BIT_INTEGER_WORD[15:8] (R/W) 16-Bit Integer Word

Table 20. Bit Descriptions for REG0011

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------------|--|-------|--------------|--------|
| [7:0] | BIT_INTEGER_WORD[15:8] | 16-Bit Integer Word. Sets the integer value of N. Updates to the PLL N counter, including FRAC1, FRAC2, and MOD2, are double buffered by this bit field. | 0x0 | User defined | R/W |

Address: 0x012, Reset: 0x00, Name: REG0012

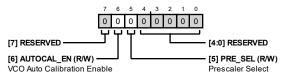
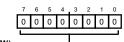


Table 21. Bit Descriptions for REG0012

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|---------------|--|-------|-------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 6 | AUTOCAL_EN | VCO Auto Calibration Enable. | 0x0 | 0x1 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| 5 | PRE_SEL | Prescaler Select. The dual modulus prescaler is set by this bit. It divides down the VCO signal such that the frequency going into the N divider is within the appropriate range. Only use the 4/5 prescaler. 0: 4/5. | 0x0 | 0x0 | R/W |
| | | 1: 8/9. | | | |
| [4:0] | RESERVED[4:0] | Reserved. | 0x0 | 0x0 | R/W |

Address: 0x014, Reset: 0x00, Name: REG0014



[7:0] FRAC1WORD[7:0] (R/W) -25-Bit Fractional 1 Word

Table 22. Bit Descriptions for REG0014

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|--|-------|--------------|--------|
| [7:0] | FRAC1WORD[7:0] | 25-Bit Fractional 1 Word. Sets the FRAC1 value of N. | 0x0 | User defined | R/W |

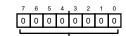
Address: 0x015, Reset: 0x00, Name: REG0015

[7:0] FRAC1WORD[15:8] (R/W) -25-Bit Fractional 1 Word

Table 23. Bit Descriptions for REG0015

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|--|-------|--------------|--------|
| [7:0] | FRAC1WORD[15:8] | 25-Bit Fractional 1 Word. Sets the FRAC1 value of N. | 0x0 | User defined | R/W |

Address: 0x016, Reset: 0x00, Name: REG0016



[7:0] FRAC1WORD[23:16] (R/W) -25-Bit Fractional 1 Word

Table 24. Bit Descriptions for REG0016

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------|--|-------|--------------|--------|
| [7:0] | FRAC1WORD[23:16] | 25-Bit Fractional 1 Word. Sets the FRAC1 value of N. | 0x0 | User defined | R/W |

Address: 0x017, Reset: 0x00, Name: REG0017

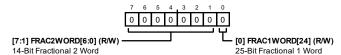


Table 25. Bit Descriptions for REG0017

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|--|-------|--------------|--------|
| [7:1] | FRAC2WORD[6:0] | 14-Bit Fractional 2 Word. Sets the FRAC2 value of N. | 0x0 | User defined | R/W |
| 0 | FRAC1WORD[24] | 25-Bit Fractional 1 Word. Sets the FRAC1 value of N. | 0x0 | | R/W |

Address: 0x018, Reset: 0x00, Name: REG0018

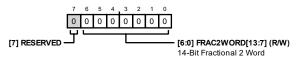
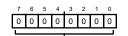


Table 26. Bit Descriptions for REG0018

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|--|-------|--------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | FRAC2WORD[13:7] | 14-Bit Fractional 2 Word. Sets the FRAC2 value of N. | 0x0 | User defined | R/W |

Address: 0x019, Reset: 0x00, Name: REG0019



[7:0] MOD2WORD[7:0] (R/W) 14-Bit Modulus 2 Word

```
Table 27 Bit Descriptions for RFG0019
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| Table | Table 27. Dit Descriptions for KEdoors | | | | | | | |
|-------|--|--|-------|--------------|--------|--|--|--|
| Bits | Bit Name | Description | Reset | Recommended | Access | | | |
| [7:0] | MOD2WORD[7:0] | 14-Bit Modulus 2 Word. Sets the MOD2 value of N. | 0x0 | User defined | R/W | | | |

Address: 0x01A, Reset: 0x00, Name: REG001A

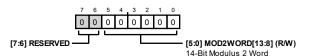
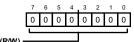


Table 28. Bit Descriptions for REG001A

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|--|-------|--------------|--------|
| [7:6] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [5:0] | MOD2WORD[13:8] | 14-Bit Modulus 2 Word. Sets the MOD2 value of N. | 0x0 | User defined | R/W |

Address: 0x01B, Reset: 0x00, Name: REG001B

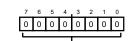


[7:0] PHASE_WORD[7:0] (R/W) 24 Bit Phase Word

Table 29. Bit Descriptions for REG001B

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|---|-------|-------------|--------|
| [7:0] | PHASE_WORD[7:0] | 24 Bit Phase Word. Sigma-delta phase seed word. For best spur | 0x0 | 0x09 | R/W |
| | | performance set the value of PHASE_WORD = 8,388,617. | | | |

Address: 0x01C, Reset: 0x00, Name: REG001C



[7:0] PHASE_WORD[15:8] (R/W) 24 Bit Phase Word

Table 30. Bit Descriptions for REG001C

| Bits | [7:0] PHASE_WORD[15:8] 24 Bit Phase Word. Sigma-delta phase seed word. For best | | Reset | Recommended | Access |
|-------|---|---|-------|-------------|--------|
| [7:0] | PHASE_WORD[15:8] | 24 Bit Phase Word. Sigma-delta phase seed word. For best | 0x0 | 0x00 | R/W |
| | | spur performance set the value of PHASE_WORD = 8,388,617. | | | |

Address: 0x01D, Reset: 0x00, Name: REG001D

0 0 0 0 0 0 0 0

[7:0] PHASE_WORD[23:16] (R/W) 24 Bit Phase Word

Table 31. Bit Descriptions for REG001D

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-------------------|---|-------|-------------|--------|
| [7:0] | PHASE_WORD[23:16] | 24 Bit Phase Word. Sigma-delta phase seed word. For best | 0x0 | 0x80 | R/W |
| | | spur performance set the value of PHASE_WORD = 8,388,617. | | | |

Address: 0x01E, Reset: 0x00, Name: REG001E

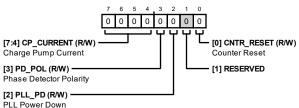


Table 32. Bit Descriptions for REG001E

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------|----------------------|-------|-------------|--------|
| [7:4] | CP_CURRENT | Charge Pump Current. | 0x0 | 2.1 mA: 0x5 | R/W |
| | | 0000: 0.35 mA. | | 4.2 mA: 0xB | |
| | | 0001: 0.70 mA. | | | |
| | | 0010: 1.05 mA. | | | |
| | | 0011: 1.40 mA. | | | |
| | | 0100: 1.75 mA. | | | |
| | | 0101: 2.10 mA. | | | |
| | | 0110: 2.45 mA. | | | |
| | | 0111: 2.80 mA. | | | |

| Bits | Bit Name | Description | Reset | Recommended | Access |
|------|------------|---|-------|-------------|--------|
| | | 1000: 3.15 mA. | | | |
| | | 1001: 3.50 mA. | | | |
| | | 1010: 3.85 mA. | | | |
| | | 1011: 4.20 mA. | | | |
| | | 1100: 4.55 mA. | | | |
| | | 1101: 4.90 mA. | | | |
| | | 1110: 5.25 mA. | | | |
| | | 1111: 5.60 mA. | | | |
| 3 | PD_POL | Phase Detector Polarity. | 0x0 | 0x1 | R/W |
| | | 0: negative (simulate unlock condition). | | | |
| | | 1: positive (nominal). | | | |
| 2 | PLL_PD | PLL Power Down. Setting this bit to 1 powers down all internal PLL blocks. The VCO, doubler, RF, and IF chains remain powered up. The registers do not lose their values. After bringing the PLL out of power-down (setting to 0), a write to REG0010 is required to relock the loop. | 0x0 | 0x0 | R/W |
| | | 0: power up. | | | |
| | | 1: power down. | | | |
| 1 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 0 | CNTR_RESET | Counter Reset. Setting this bit to 1 holds the N counter and R counter in reset. No signals enter the phase frequency detector. | 0x0 | 0x0 | R/W |
| | | 0: normal operation. | | | |
| | | 1: counter reset. | | | |

Address: 0x01F, Reset: 0x00, Name: REG001F

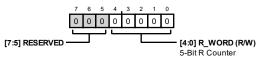


Table 33. Bit Descriptions for REG001F

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------|---|-------|-------------|--------|
| [7:5] | RESERVED | Reserved. | 0x0 | 0x0 | R |
| [4:0] | R_WORD | 5-Bit R Counter. Programming to 0x0, results in divide by 32. | 0x0 | ≥0x1 | R/W |

Address: 0x020, Reset: 0x00, Name: REG0020

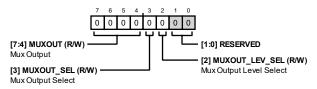


Table 34. Bit Descriptions for REG0020

| Bits | Bit Name | Description | Reset | Recommended | Access |
|---------------------------|---|---------------------------|-------|-------------|--------|
| [7:4] | MUXOUT | Mux Output | 0x0 | 0x1 | R/W |
| | 0000: tristate (high impedance, only when MUXOUT_SEL = 0) | | | | |
| 0001: digital lock detect | | 0001: digital lock detect | | | |
| | | 0010: charge pump up | | | |
| | | 0011: charge pump down | | | |
| | | 0100: RDIV/2 | | | |

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|--|-------|-------------|--------|
| | | 0101: NDIV/2 | | | |
| | | 0110: VCO test modes | | | |
| | | 1000: logic high | | | |
| 3 | MUXOUT_SEL | Mux Output Select | 0x0 | Data: 0x0, | R/W |
| | | 0: SDO pin used for register read back | | mux: 0x1 | |
| | | 1: SDO pin used for MUXOUT signal | | | |
| 2 | MUXOUT_LEV_SEL | Mux Output Level Select | 0x0 | 0x1 | R/W |
| | | 0: 1.8 V logic | | | |
| | | 1: 3.3 V logic | | | |
| [1:0] | RESERVED | Reserved | 0x0 | 0x0 | R |

Address: 0x022, Reset: 0x00, Name: REG0022

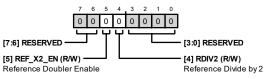


Table 35. Bit Descriptions for REG0022

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|--------------------------|-------|--------------|--------|
| [7:6] | RESERVED | Reserved | 0x0 | 0x0 | R/W |
| 5 | REF_X2_EN | Reference Doubler Enable | 0x0 | User defined | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| 4 | RDIV2 | Reference Divide by 2 | 0x0 | User defined | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| [3:0] | RESERVED | Reserved | 0x0 | 0x0 | R/W |

Address: 0x025, Reset: 0x00, Name: REG0025

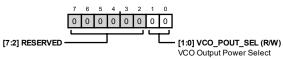
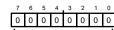
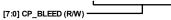


Table 36. Bit Descriptions for REG0025

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------|-------------------------|-------|-------------|--------|
| [7:2] | RESERVED | Reserved | 0x0 | 0x0 | R/W |
| [1:0] | VCO_POUT_SEL | VCO Output Power Select | 0x0 | 0x3 | R/W |
| | | 00: minimum | | | |
| | | 11: maximum | | | |

Address: 0x026, Reset: 0x00, Name: REG0026





8-Bit Charge Pump Bleed Current

Table 37. Bit Descriptions for REG0026

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------|----------------------------------|-------|-------------|--------|
| [7:0] | CP_BLEED | 8-Bit Charge Pump Bleed Current. | 0x0 | 0x73 | R/W |

Address: 0x027, Reset: 0x00, Name: REG0027

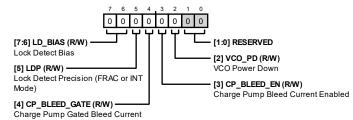


Table 38. Bit Descriptions for REG0027

| Bits | Bit Name | Tit Name Description | | Recommended | Access |
|-------|---------------|--|-----|--------------------------------|--------|
| [7:6] | LD_BIAS | Lock Detect Bias. Sets lock detect window. | 0x0 | 0x3 | R/W |
| | | 00: 5 ns (if LDP = 0). | | | |
| | | 01: 6 ns. | | | |
| | | 10: 8 ns. | | | |
| | | 11: 12 ns (for large values of bleed current). | | | |
| 5 | LDP | Lock Detect Precision (FRAC or INT Mode). Controls the sensitivity | 0x0 | FRAC: 0x0, | R/W |
| | | of the digital lock detect. | | INT: 0x1 | |
| | | 0: FRAC mode (5 ns). | | | |
| | | 1: INT mode (2.4 ns). | | | |
| 4 | CP_BLEED_GATE | Charge Pump Gated Bleed Current. | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable (digital lock detect must also be enabled). | | | |
| 3 | CP_BLEED_EN | Charge Pump Bleed Current Enabled. Bleed current applies a slight offset within the charge pump to improve linearity. The result is lower phase noise and improved spurious performance. Set to 1 to enable negative bleed current. | 0x0 | FRAC: 0x1, INT: 0x0 | R/W |
| | | 0: disable. | | | |
| - | | 1: enable. | | | |
| 2 | VCO_PD | VCO Power Down. | 0x0 | 0x0 | R/W |
| | | 0: power up. | | | |
| | | 1: power down. | | | |
| [1:0] | RF_PBS | Prescaler Bias Select. For temperature \leq 0°C, set to value 1. For temperature > 0°C, set to value 2. | 0x0 | TA ≤ 0°C: 0x1 TA > 0°C: 0x2 | R/W |
| | | 00: +10%. | | | |
| | | 01: Nominal. | | | |
| | | 10: -10%. | | | |
| | | 11: -20%. | | | |

Address: 0x028, Reset: 0x00, Name: REG0028

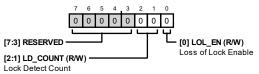


Table 39. Bit Descriptions for REG0028

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|---|--|-------|-------------|--------|
| [7:3] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [2:1] | [2:1] LD_COUNT Lock Detect Count. Sets the number of PFD cycles within the lock detect window before lock detect goes high. | | 0x0 | 0x1 | R/W |
| | | 00: 1024 cycles. | | | |
| | | 01: 2048 cycles. | | | |
| | | 10: 4096 cycles. | | | |
| | | 11: 8192 cycles. | | | |
| 0 | LOL_EN | Loss of Lock Enable. When loss of lock is enabled, if the digital lock detect is asserted, and the reference signal is removed, then the digital lock detect goes low. It is recommended to set this bit to 1. | 0x0 | 0x1 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |

Address: 0x02A, Reset: 0x00, Name: REG002A

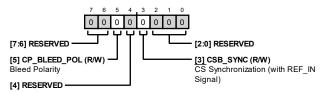


Table 40. Bit Descriptions for REG002A

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|---------------|---|-------|-------------|--------|
| [7:6] | RESERVED[1:0] | Reserved | 0x0 | 0x0 | R/W |
| 5 | CP_BLEED_POL | Bleed Polarity | 0x0 | 0x0 | R/W |
| | | 0: negative (nominal) | | | |
| | | 1: positive (not recommended) | | | |
| 4 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 3 | CSB_SYNC | CS Synchronization (with REF_IN Signal) | 0x0 | 0x0 | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| [2:0] | RESERVED | Reserved | 0x0 | 0x0 | R/W |

Address: 0x02B, Reset: 0x00, Name: REG002B

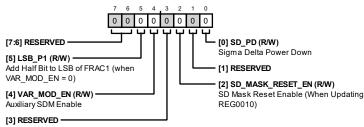


Table 41. Bit Descriptions for REG002B

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------|--|-------|-------------|--------|
| [7:6] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 5 | LSB_P1 | Add Half Bit to LSB of FRAC1 (when VAR_MOD_EN = 0). | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| 4 | VAR_MOD_EN | Auxiliary SDM Enable. | 0x0 | FRAC: 0x1, | R/W |
| | | 0: disable (FRAC2 = 0). | | INT: 0x0 | |
| | | 1: enable (FRAC2 ≠ 0). | | | |
| 3 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 2 | SD_MASK_RESET_EN | SD Mask Reset Enable (When Updating REG0010). | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| 1 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 0 | SD_PD | Sigma Delta Power Down. Set this bit if FRAC1 = FRAC2 = 0. | 0x0 | FRAC: 0x0, | R/W |
| | | 0: power up (FRAC mode). | | INT: 0x1 | |
| | | 1: power down (INT mode). | | | |

Address: 0x02C, Reset: 0x00, Name: REG002C

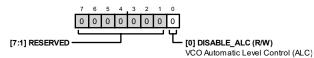


Table 42. Bit Descriptions for REG002C

| Bits | Bit Name | Description | | Recommended | Access |
|-------|-------------|--|--|-------------|--------|
| [7:1] | RESERVED | Reserved. | | 0x0 | R/W |
| 0 | DISABLE_ALC | /CO Automatic Level Control (ALC). Keep this bit set to 1. 0 | | 0x1 | R/W |
| | | 0: enable. | | | |
| | | 1: disable. | | | |

Address: 0x030, Reset: 0x00, Name: REG0030

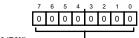
0 0 0 0 0 0 0

[7:0] VCO_BAND_DIV (R/W) -VCO Band Select Divider

Table 43. Bit Descriptions for REG0030

| Bits | Bit Name | Description | | Recommended | Access |
|-------|--------------|--|-----|--------------|--------|
| [7:0] | VCO_BAND_DIV | VCO Band Select Divider. $f_{BSC} = f_{PFD}/VCO_BAND_DIV \le 2.4$ MHz. | 0x0 | User defined | R/W |

Address: 0x031, Reset: 0x00, Name: REG0031



[7:0] TIMEOUT[7:0] (R/W) — Timeout

Table 44. Bit Descriptions for REG0031

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------|--|-------|--------------|--------|
| [7:0] | TIMEOUT[7:0] | Timeout. See the Autocalibration Lock Time section | 0x0 | User defined | R/W |
| | | for details. | | | |

Address: 0x032, Reset: 0x00, Name: REG0032

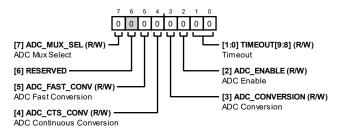
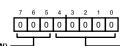


Table 45. Bit Descriptions for REG0032

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------------------------|--|-------|--------------|--------|
| 7 | ADC_MUX_SEL | ADC Mux Select. | 0x0 | 0x0 | R/W |
| | | 0: ADC input connected to proportional to absolute temperature (PTAT) voltage. | | | |
| | | 1: ADC input connected to scaled VTUNE voltage. | | | |
| 6 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 5 | ADC_FAST_CONV ADC Fast Conversion. | | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| 4 | ADC_CTS_CONV | ADC Continuous Conversion. | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| 3 | ADC_CONVERSION | ADC Conversion. | 0x0 | 0x0 | R/W |
| | | 0: no ADC conversion. | | | |
| | | 1: perform ADC conversion. | | | |
| 2 | ADC_ENABLE | ADC Enable | 0x0 | 0x0 | R/W |
| | | 0: disable. | | | |
| | | 1: enable. | | | |
| [1:0] | TIMEOUT[9:8] | Timeout. See the Autocalibration Lock Time section for details. | 0x0 | User defined | R/W |

Address: 0x033, Reset: 0x00, Name: REG0033



[7:5] VCO_FSM_READBACK (R/W) VCO Finite State Machine Read Back [4:0] SYNTH_LOCK_TIMEOUT (R/W) Synthesizer Lock Timeout

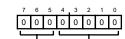
[4:0] VCO_ALC_TIMEOUT (R/W)

VCO ALC Timeout

Table 46. Bit Descriptions for REG0033

| Bits | Bit Name | Description | | Recommended | Access |
|-------|--------------------|--|-----|--------------|--------|
| [7:5] | VCO_FSM_READBACK | VCO Finite State Machine Read Back. | 0x0 | 0x0 | R/W |
| | | 000: checkerboard. | | | |
| | | 001: read back core and band. | | | |
| | | 101: ADC reading (temperature sensor). | | | |
| [4:0] | SYNTH_LOCK_TIMEOUT | Synthesizer Lock Timeout. See the Autocalibration Lock | 0x0 | User defined | R/W |
| | | Time section for details. | | | |

Address: 0x034, Reset: 0x00, Name: REG0034

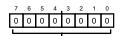


[7:5] VCO_FSM_TEST_MODES (R/W) VCO Finite State Machine Test Modes

Table 47. Bit Descriptions for REG0034

| Bits | Bit Name | Description | | Recommended | Access |
|-------|--------------------|---|-----|-------------|--------|
| [7:5] | VCO_FSM_TEST_MODES | VCO Finite State Machine Test Modes. | 0x0 | 0x4 | R/W |
| | | 000: normal operation. | | | |
| | | 010: manual overwrite VCO core and band. | | | |
| | | 100: manual overwrite of VCO calibration voltage. | | | |
| [4:0] | VCO_ALC_TIMEOUT | VCO ALC Timeout. Keep this bit set to 0. | 0x0 | 0x0 | R/W |

Address: 0x035, Reset: 0x00, Name: REG0035



[7:0] ADC_CLK_DIVIDER (R/W) ADC Clock Divider

Table 48. Bit Descriptions for REG0035

| Bits | Bit Name | Description | | Recommended | Access |
|-------|-----------------|--|-----|-------------|--------|
| [7:0] | ADC_CLK_DIVIDER | ADC Clock Divider. ADC Clock = $f_{PFD}/((ADC_CLK_DIVIDER \times 4) +$ | 0x0 | 0xFF | R/W |
| | | 2). | | | |

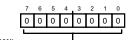
Address: 0x036, Reset: 0x00, Name: REG0036

[7:0] ICP_ADJUST_OFFSET (R/W) Reserved

Table 49. Bit Descriptions for REG0036

| Bits | Bits Bit Name | | Description | Reset | Recommended | Access |
|-------|---------------|-----------|-------------|-------|-------------|--------|
| [7:0] | ICP_ADJUS | ST_OFFSET | Reserved | 0x0 | 0x30 | R/W |

Address: 0x037, Reset: 0x00, Name: REG0037



[7:0] SI_BAND_SEL (R/W) ______ VCO Band Select (Bypass Autocalibration)

Table 50. Bit Descriptions for REG0037

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-------------|--|-------|-------------|--------|
| [7:0] | SI_BAND_SEL | VCO Band Select (Bypass Autocalibration) | 0x0 | 0x0 | R/W |

Address: 0x038, Reset: 0x00, Name: REG0038

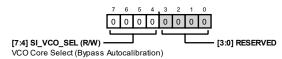


Table 51. Bit Descriptions for REG0038

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------|--|-------|-------------|--------|
| [7:4] | SI_VCO_SEL | VCO Core Select (Bypass Autocalibration) | 0x0 | 0x0 | R/W |
| [3:0] | RESERVED | Reserved | 0x0 | 0x0 | R/W |

Address: 0x039, Reset: 0x00, Name: REG0039

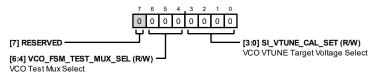


Table 52. Bit Descriptions for REG0039

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------------|---------------------|-------|-------------|--------|
| 7 | RESERVED | Reserved | 0x0 | 0x0 | R |
| [6:4] | VCO_FSM_TEST_MUX_SEL | VCO Test Mux Select | 0x0 | 0x0 | R/W |
| | | 000: busy | | | |
| | | 001: N band | | | |
| | | 010: R band | | | |
| | | 011: Reserved | | | |
| | | 100: timeout clock | | | |
| | | 101: bias minimum | | | |
| | | 110: ADC busy | | | |
| | | 111: logic low | | | |

Data Sheet

ADMV4530

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------|---------------------------------|-------|-------------|--------|
| [3:0] | SI_VTUNE_CAL_SET | VCO VTUNE Target Voltage Select | 0x0 | 0x7 | R/W |
| | | 0: 0.58 V | | | |
| | | 1: 0.73 V | | | |
| | | 10: 0.88 V | | | |
| | | 11: 1.03 V | | | |
| | | 100: 1.18 V | | | |
| | | 101: 1.33 V | | | |
| | | 110: 1.48 V | | | |
| | | 111: 1.63 V | | | |
| | | 1000: 1.78 V | | | |
| | | 1001: 1.93 V | | | |
| | | 1010: 2.08 V | | | |
| | | 1011: 2.23 V | | | |
| | | 1100: 2.38 V | | | |
| | | 1101: 2.53 V | | | |
| | | 1110: 2.68 V | | | |
| | | 1111: 2.83 V | | | |

Address: 0x03A, Reset: 0x00, Name: REG003A

[7:0] ADC_OFFSET (R/W)

Table 53. Bit Descriptions for REG003A

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------|---------------------------------------|-------|-------------|--------|
| [7:0] | ADC_OFFSET | VCO Calibration ADC Offset Correction | 0x0 | | R/W |

Address: 0x03E, Reset: 0x00, Name: REG003E

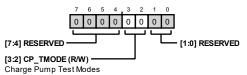
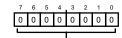


Table 54. Bit Descriptions for REG003E

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------|--|-------|-------------|--------|
| [7:4] | RESERVED | Reserved | 0x0 | 0x0 | R/W |
| [3:2] | CP_TMODE | Charge Pump Test Modes 00: tristate 11: normal | 0x0 | 0x3 | R/W |
| [1:0] | RESERVED | Reserved | 0x0 | 0x | R/W |

Address: 0x06E, Reset: 0x00, Name: REG006E



[7:0] VCO_DATA_READBACK[7:0] (R) VCO Data Read Back

Table 55. Bit Descriptions for REG006E

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|------------------------|--------------------|-------|-------------|--------|
| [7:0] | VCO_DATA_READBACK[7:0] | VCO Data Read Back | 0x0 | N/A | R |

Address: 0x06F, Reset: 0x00, Name: REG006F

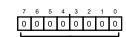


Table 56. Bit Descriptions for REG006F

| Bits | Bit Name | | Description | Reset | Recommended | Access |
|-------|-----------|----------------|--------------------|-------|-------------|--------|
| [7:0] | VCO_DATA_ | READBACK[15:8] | VCO Data Read Back | 0x0 | N/A | R |

Address: 0x073, Reset: 0x00, Name: REG0073

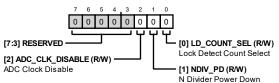


Table 57. Bit Descriptions for REG0073

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------------|---|-------|-------------|--------|
| [7:3] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 2 | ADC_CLK_DISABLE | ADC Clock Disable. ADC_ENABLE overwrites this bit. | 0x0 | 0x0 | R/W |
| | | 0: enable. | | | |
| | | 1: disable. | | | |
| 1 | NDIV_PD | N Divider Power Down. | 0x0 | 0x0 | R/W |
| | | 0: power up. | | | |
| | | 1: power down. | | | |
| 0 | LD_COUNT_SEL | Lock Detect Count Select. Declares lock in 32, 64, 128, or 256 phase frequency detector cycles vs. the default 1024, 2048, 4096, or 8192 phase frequency detector cycles. | 0x0 | 0x0 | R/W |
| | | 0: nominal (LD_COUNT). | | | |
| | | 1: divided (LD_COUNT/32). | | | |

Address: 0x07C, Reset: 0x00, Name: REG007C

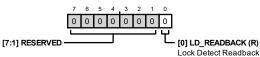


 Table 58. Bit Descriptions for REG007C

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-------------|----------------------|-------|-------------|--------|
| [7:1] | RESERVED | Reserved. | 0x0 | N/A | R |
| 0 | LD_READBACK | Lock Detect Readback | 0x0 | N/A | R |

Address: 0x100, Reset: 0x03, Name: REG0100

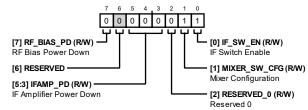


Table 59. Bit Descriptions for REG0100

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------|----------------------------|-------|----------------|--------|
| 7 | RF_BIAS_PD | RF Bias Power Down | 0x0 | 0x0 | R/W |
| | | 0: power up | | | |
| | | 1: power down | | | |
| 6 | RESERVED | Reserved | 0x0 | 0x0 | R/W |
| [5:3] | IFAMP_PD | IF Amplifier Power Down | 0x0 | I/Q mode: 0x7, | R/W |
| | | 000: power up (IF mode). | | IF mode: 0x0 | |
| | | 111: power down (I/Q mode) | | | |
| 2 | RESERVED_0 | Reserved 0 | 0x0 | 0x0 | R/W |
| 1 | MIXER_SW_CFG | Mixer Configuration | 0x1 | 0x1 | R/W |
| | | 0: mixer bypassed | | | |
| | | 1: enable mixer | | | |
| 0 | IF_SW_EN | IF Switch Enable | 0x1 | I/Q mode: 0x0, | R/W |
| | | 0: disable (I/Q mode) | | IF mode: 0x1 | |
| | | 1: enable (IF mode) | | | |

Address: 0x101, Reset: 0x7F, Name: REG0101

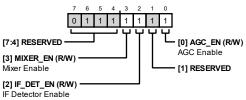


Table 60. Bit Descriptions for REG0101

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|-------------------------------|-------|----------------|--------|
| [7:4] | RESERVED | Reserved. | 0x7 | 0x7 | R/W |
| 3 | MIXER_EN | Mixer Enable | 0x1 | 0x1 | R/W |
| | | 0: disabled. | | | |
| | | 1: enabled (I/Q and IF modes) | | | |
| 2 | IF_DET_EN | IF Detector Enable | 0x1 | I/Q mode: 0x0, | R/W |
| | | 0: disable (I/Q mode) | | IF mode: 0x1 | |
| | | 1: enable (IF mode) | | | |
| 1 | RESERVED | Reserved | 0x1 | 0x0 | R/W |
| 0 | AGC_EN | AGC Enable | 0x1 | I/Q mode: 0x0, | R/W |
| | | 0: disable (I/Q mode) | | IF mode: 0x1 | |
| | | 1: enable (IF mode) | | | |

Address: 0x102, Reset: 0x3F, Name: REG0102

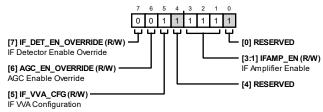


Table 61. Bit Descriptions for REG0102

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------------|---|-------|----------------|--------|
| 7 | IF_DET_EN_OVERRIDE | IF Detector Enable Override | 0x0 | 0x0 | R/W |
| | | 0: disable (IF detector only active in power-down mode) | | | |
| | | 1: enable (IF detector always on) | | | |
| 6 | AGC_EN_OVERRIDE | AGC Enable Override | 0x0 | 0x0 | R/W |
| | | 0: disable (IF AGC only active in power-down mode) | | | |
| | | 1: enable (IF AGC always on) | | | |
| 5 | IF_VVA_CFG | IF VVA Configuration | 0x1 | I/Q mode: 0x0, | R/W |
| | | 0: disable (I/Q mode) | | IF mode: 0x1 | |
| | | 1: enable (IF mode) | | | |
| 4 | RESERVED | Reserved | 0x1 | 0x1 | R/W |
| [3:1] | IFAMP_EN | IF Amplifier Enable | 0x7 | I/Q mode: 0x0, | R/W |
| | | 000: disable (I/Q mode) | | IF mode: 0x7 | |
| | | 111: enable (IF mode) | | | |
| 0 | RESERVED | Reserved | 0x1 | 0x1 | R/W |

Address: 0x103, Reset: 0x51, Name: REG0103

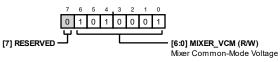


Table 62. Bit Descriptions for REG0103

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|--|-------|--------------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | MIXER_VCM | Mixer Common-Mode Voltage. | 0x51 | I/Q mode: 0x5D, | R/W |
| | | In I/Q mode, for $V_{CM} = 0.0$ V to 1.5 V, set MIXER_VCM = ROUND(23.8 × V_{CM} + 80.7). In I/Q mode, V_{CM} for = 1.5 V to 2.5 V, set MIXER_VCM = ROUND(23.8 × V_{CM} + 1.3). The default in I/Q mode for V_{CM} = 0 V, is MIXER_VCM = 81 = 0x51. | | IF mode: 0x5B | |
| | | In IF mode, set MIXER_VCM = ROUND(0.3 × (128 – TARGET_MIXER_DC_OFFSET) + 80.7) | | | |

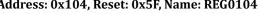


Table 63. Bit Descriptions for REG0104

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-------------|----------------------------|-------|-------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | PHASE_ADJ_I | LO Phase Adjustment Path I | 0x5F | 0x5F | R/W |

٥

[7] RESERVED

[7] RESERVED

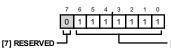
Address: 0x105, Reset: 0x5F, Name: REG0105

Table 64. Bit Descriptions for REG0105

| Bits Bit Name | | Description Reset | | Recommended | Access | |
|---------------|-------------|----------------------------|------|-------------|--------|--|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W | |
| [6:0] | PHASE_ADJ_Q | LO Phase Adjustment Path Q | 0x5F | 0x5F | R/W | |

1 1

Address: 0x106, Reset: 0x7F, Name: REG0106



0

0

1 1

> [6:0] MIXER_DC_OFFSET_IP (R/W) Mixer DC Offset Adjustment IP

[6:0] PHASE_ADJ_I (R/W) LO Phase Adjustment Path I

[6:0] PHASE_ADJ_Q (R/W) LO Phase Adjustment Path Q

Table 65. Bit Descriptions for REG0106

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------------|--|-------|-----------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | MIXER_DC_OFFSET_IP | Mixer DC Offset Adjustment IP. For I/Q mode, the default = | 0x7F | I/Q mode: 0x7F, | R/W |
| | | 127 = 0x7F. For IF mode, the default = $95 = 0x5F$. | | IF mode: 0x5F | |

Address: 0x107, Reset: 0x7F, Name: REG0107

[7] RESERVED

[6:0] MIXER_DC_OFFSET_IN (R/W) Mixer DC Offset Adjustment IN

Table 66. Bit Descriptions for REG0107

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------------|---|-------|----------------------------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | MIXER_DC_OFFSET_IN | Mixer DC Offset Adjustment IN. In I/Q mode, the default = 127 = 0x7F. For IF mode, the default = 95 = 0x5F. | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/W |

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Address: 0x108, Reset: 0x7F, Name: REG0108

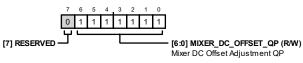


Table 67. Bit Descriptions for REG0108

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------------|--|-------|----------------------------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | MIXER_DC_OFFSET_QP | Mixer DC Offset Adjustment QP. For I/Q mode, the default = 127 = 0x7F. For IF mode, the default = 95 = 0x5F. | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/W |

Address: 0x109, Reset: 0x7F, Name: REG0109

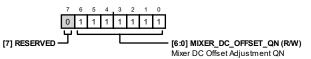


Table 68. Bit Descriptions for REG0109

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------------|--|-------|----------------------------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | MIXER_DC_OFFSET_QN | Mixer DC Offset Adjustment QN. For I/Q mode, the default = 127 = 0x7F. For IF mode, the default = 95 = 0x5F. | 0x7F | I/Q mode: 0x7F, IF mode: 0x5F | R/W |

Address: 0x10C, Reset: 0x08, Name: REG010C

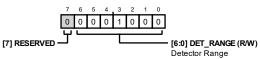


Table 69. Bit Descriptions for REG010C

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|--|-------|--------------|--------|
| 7 | RESERVED | Reserved | 0x0 | 0x0 | R/W |
| [6:0] | DET_RANGE | Detector Range. Refer to the IF AGC Configuration section for details. | 0x8 | User defined | R/W |

Address: 0x10D, Reset: 0x69, Name: REG010D

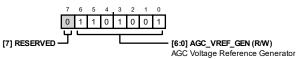


Table 70. Bit Descriptions for REG010D

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------|--|-------|--------------|--------|
| 7 | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [6:0] | AGC_VREF_GEN | AGC Voltage Reference Generator. | 0x69 | User defined | R/W |
| | | Refer to the IF AGC Configuration section for details. | | | |

Address: 0x115, Reset: 0x08, Name: REG0115

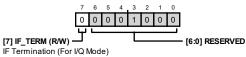


Table 71. Bit Descriptions for REG0115

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------|-------------------------------|-------|---------------|--------|
| 7 | IF_TERM | IF Termination (For I/Q Mode) | 0x0 | I/Q mode: 0x1 | R/W |
| | | 0: unterminated (IF mode) | | IF mode: 0x0 | |
| | | 1: terminated (I/Q mode) | | | |
| [6:0] | RESERVED | Reserved | 0x8 | 0x8 | R/W |

Address: 0x116, Reset: 0x00, Name: REG0116

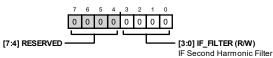
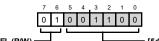


Table 72. Bit Descriptions for REG0116

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|-----------|---------------------------|-------|-------------|--------|
| [7:4] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| [3:0] | IF_FILTER | IF Second Harmonic Filter | 0x0 | 0x0 | R/W |
| | | 0000: ~6.75 GHz | | | |
| | | 0001: ~6.50 GHz | | | |
| | | 0010: ~6.25 GHz | | | |
| | | 0011: ~6.00 GHz | | | |
| | | 0100: ~5.75 GHz | | | |
| | | 0101: ~5.50 GHz | | | |
| | | 0110: ~5.25 GHz | | | |
| | | 0111: ~5.00 GHz | | | |
| | | 1000: ~4.75 GHz | | | |
| | | 1001: ~4.50 GHz | | | |

Address: 0x117, Reset: 0x4C, Name: REG0117



[7:6] REG_PAGE_SEL (R/W) -Register Map Page Select

[5:0] RESERVED

Table 73. Bit Descriptions for REG0117

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|--------------|--|-------|-------------|--------|
| [7:6] | REG_PAGE_SEL | Register Map Page Select | 0x1 | PLL: 0x0, | R/W |
| | | 0: read from Register 0x010 to Register 0x07C (the PLL section) | | mixer: 0x1 | |
| | | 1: read from Register 0x000 to Register 0x00D or Register 0x100 to | | | |
| | | Register 0x119 (the mixer section) | | | |
| [5:0] | RESERVED | Reserved | 0xC | 0xC | R/W |

Address: 0x119, Reset: 0x08, Name: REG0119

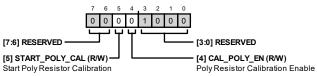


Table 74. Bit Descriptions for REG0119

| Bits | Bit Name | Description | Reset | Recommended | Access |
|-------|----------------|----------------------------------|-------|-------------|--------|
| [7:6] | RESERVED | Reserved. | 0x0 | 0x0 | R/W |
| 5 | START_POLY_CAL | Start Poly Resistor Calibration | 0x0 | 0x0 | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| 4 | CAL_POLY_EN | Poly Resistor Calibration Enable | 0x0 | 0x0 | R/W |
| | | 0: disable | | | |
| | | 1: enable | | | |
| [3:0] | RESERVED | Reserved | 0x8 | 0x8 | R/W |

OUTLINE DIMENSIONS

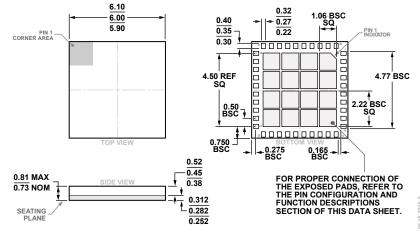


Figure 101. 40-Terminal Land Grid Array [LGA] (CC-40-8) Dimensions shown in millimeters

ORDERING GUIDE

| Model ¹ | Temperature Range | Package Description | Package Option |
|--------------------|-------------------|-----------------------------------|----------------|
| ADMV4530ACCZ | -40°C to +85°C | 40-Terminal Land Grid Array [LGA] | CC-40-8 |
| ADMV4530ACCZ-RL7 | -40°C to +85°C | 40-Terminal Land Grid Array [LGA] | CC-40-8 |
| ADMV4530IF-EVALZ | | IF Mode Evaluation Board | |
| ADMV4530IQ-EVALZ | | I/Q Mode Evaluation Board | |

¹ Z = RoHS Compliant Part.

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